

**Welcome To
Globalbridge's World**

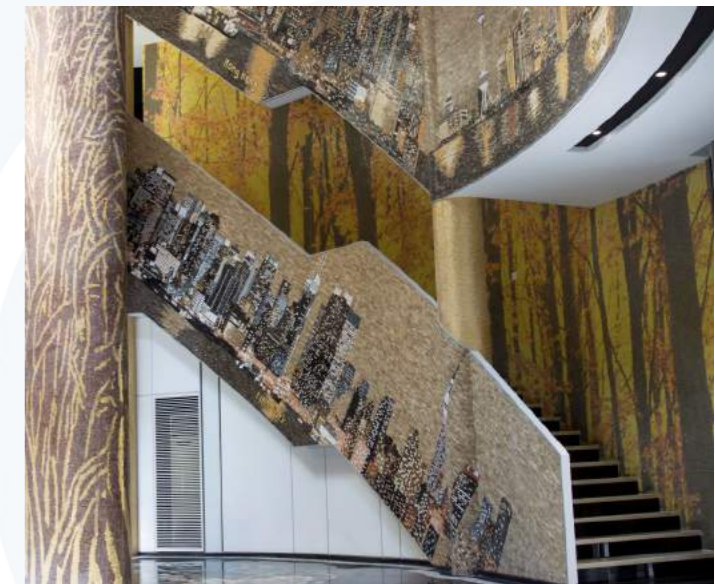
ABOUT GLOBALBRIDGE

Foshan Global Bridge Building Materials Co.,Ltd. is a company helping our clients to grow business by designing, sourcing and delivery mosaic products. We established in 2006, have a modern showroom and office building of 4 thousand 2 hundred Square meters.

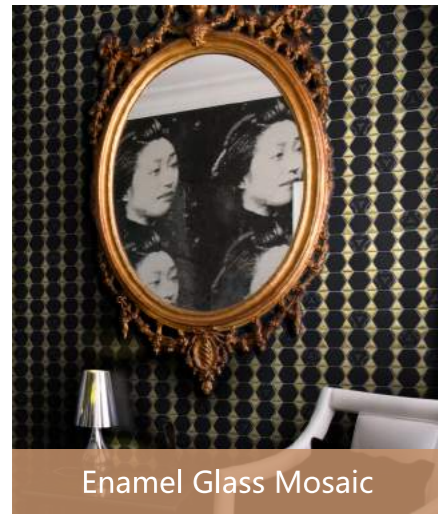
Our services provide exceptional value by the quality and innovation on time. Our customers see us as their solution provider and we have already successfully cooperating with nearly 3 hundred clients and some of them became our sole distributors and partners.

In terms of our history, we are an innovative mosaic company specializing in mosaic wholesale and project for 12 years. Today Global Bridge provides a vast array of products, designs, consulting and technical information for the benefit of our customers.

Our mission is to help our clients growing business. Hope we have the opportunity to cooperate and be a win-win partner.



Please kindly contact with our sales to get the whole catalogue of Global Bridge.



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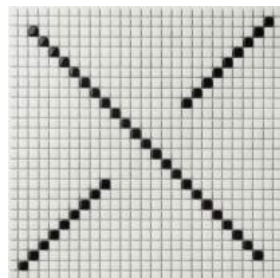


Ceramic Mosaic

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EXAMPLE Product Data Explanation



DE-EMP03A^①
 305x305x6mm/pcs^②
 Chip Size:10x10x6mm^③
 11.39 kgs/ctn^④ 1.02 sqm/ctn^⑤
 90 ctns/plt^⑥ 11 pcs/ctn^⑦

- ①: Product name
- ②: Sheet size
- ③: Chip Size
- ④: Weight of each carton
- ⑤: Square Meters of each carton
- ⑥: Number of cartons per pallet
- ⑦: Number of sheets per carton

PICTOGRAMS Range Of Application

-  Outdoor
Balcony / Courtyard / Open Space
-  Wet Area
Shower Place / Sauna / Spa
-  Splash Area
Kitchen / Wash basin
-  Permanent Wet Area
Swimming Pool / Fountain / Fish Pond
-  Floor
-  Wall



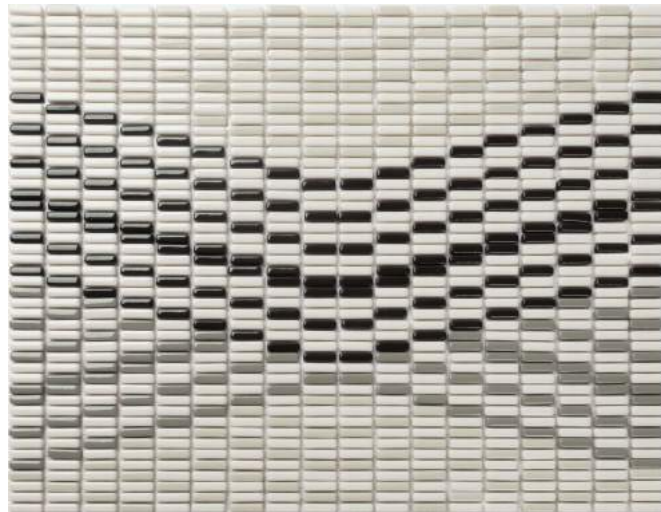
Our mission is to help our clients growing business.



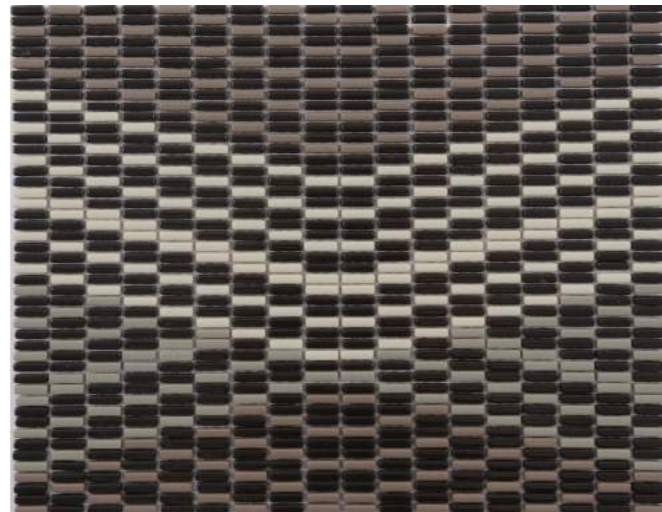
Meeting Point



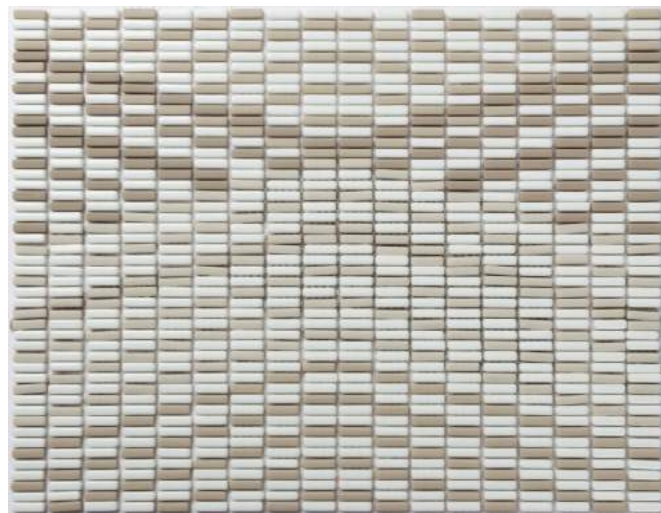
DE-EMP01A
381x291x6mm/pcs
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12.85 kgs/ctn 1.22 sqm/ctn
80 ctns/plt 11 pcs/ctn



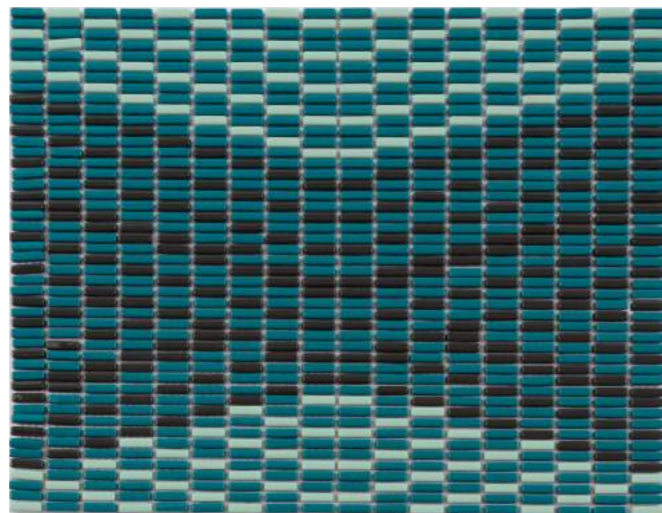
DE-EMP01B
 381x291x6mm/pcs
 Chip Size:20x5x6mm
 12.85 kgs/ctn 1.22 sqm/ctn
 80 ctns/plt 11 pcs/ctn



DE-EMP01C
 381x291x6mm/pcs
 Chip Size:20x5x6mm
 12.85 kgs/ctn 1.22 sqm/ctn
 80 ctns/plt 11 pcs/ctn



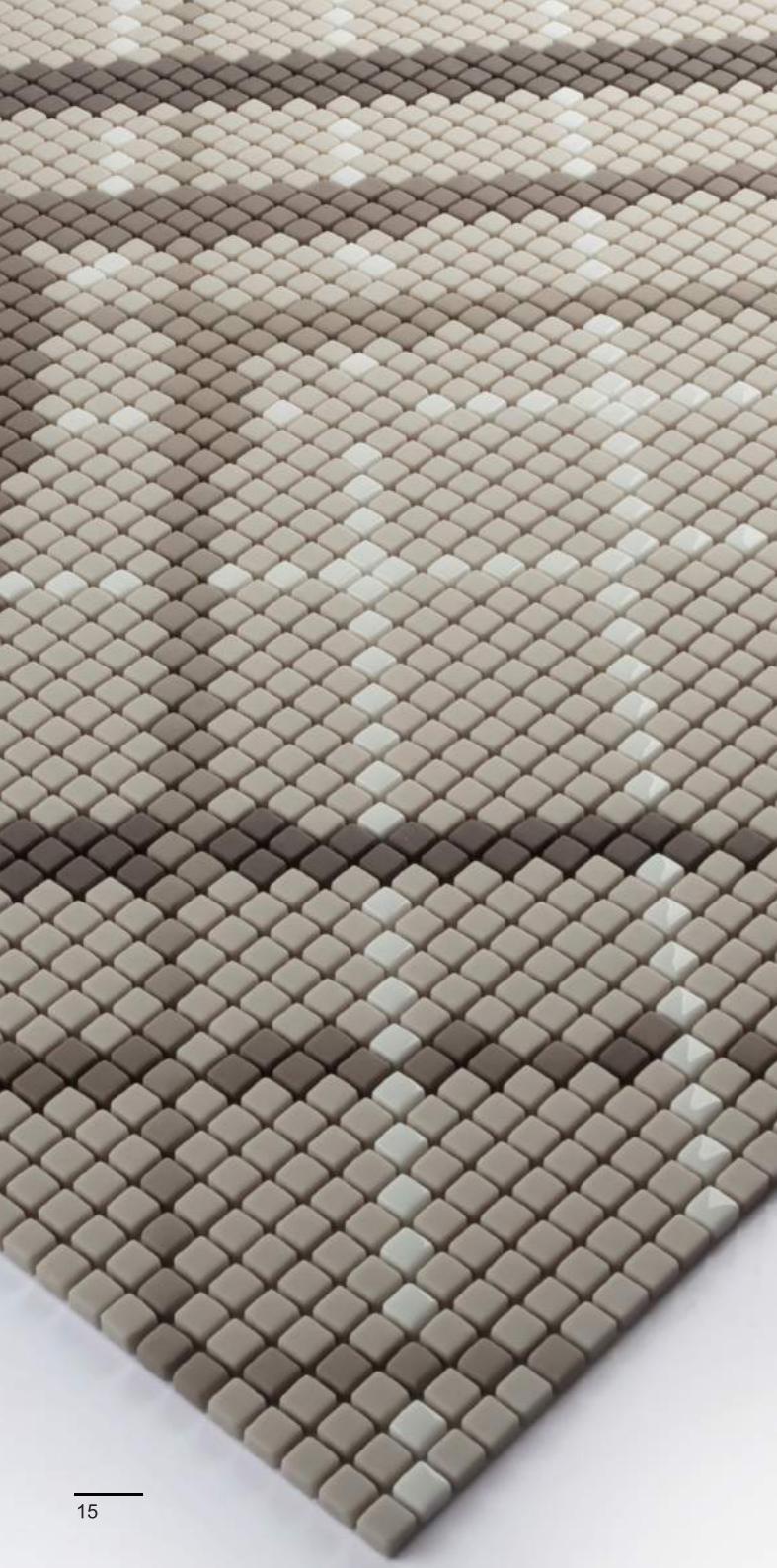
DE-EMP01D
 381x291x6mm/pcs
 Chip Size:20x5x6mm
 12.85 kgs/ctn 1.22 sqm/ctn
 80 ctns/plt 11 pcs/ctn



DE-EMP01E
 381x291x6mm/pcs
 Chip Size:20x5x6mm
 12.85 kgs/ctn 1.22 sqm/ctn
 80 ctns/plt 11 pcs/ctn

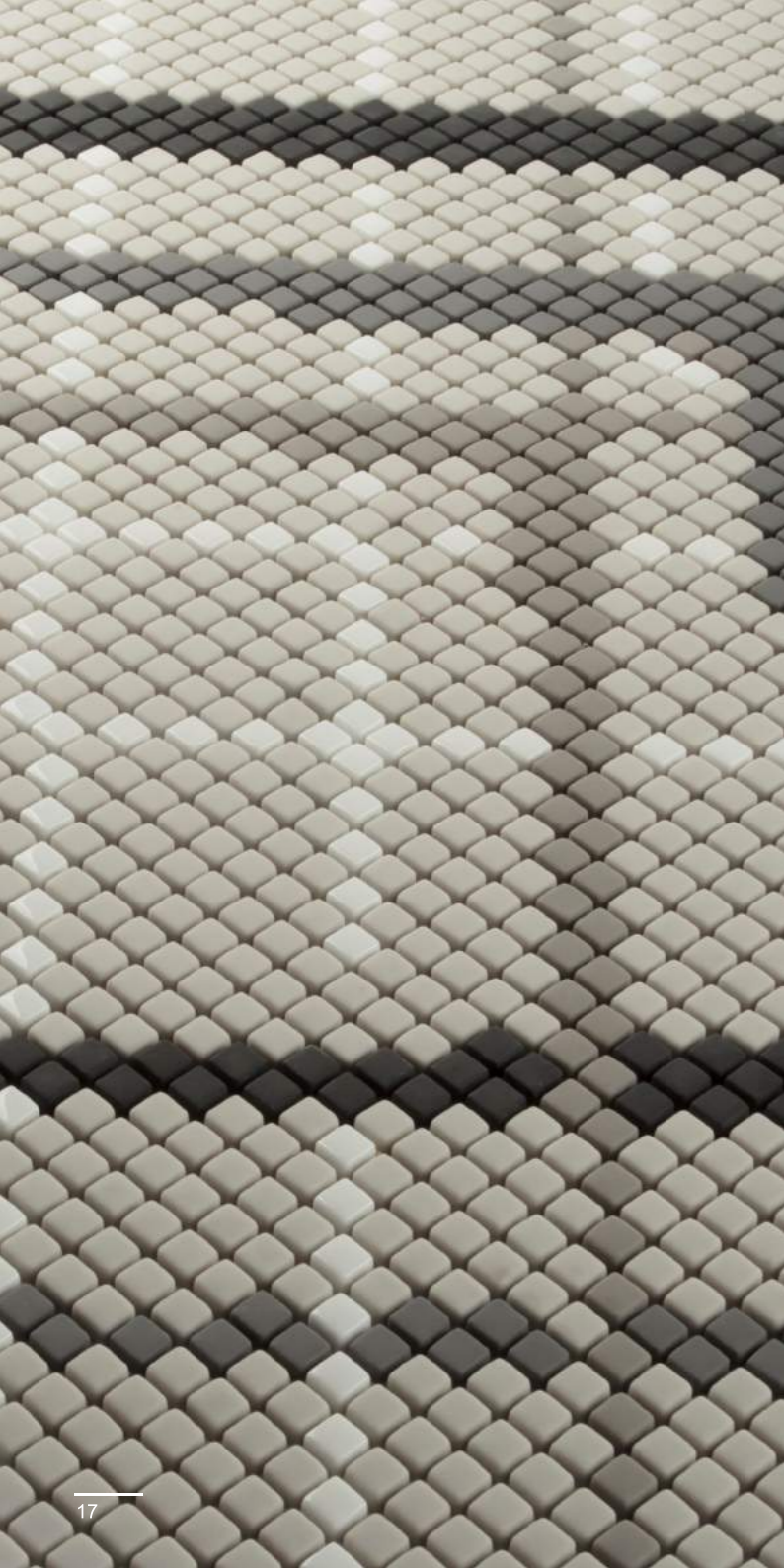


Iteration



DE-EMPO2A
588x588x6mm/unit 294x294x6mm/pcs
Chip Size:10x10x6mm
19.11 kgs/ctn 1.73 sqm/ctn
54 ctns/plt 20 pcs/ctn





DE-EMP02B
588x588x6mm/unit 294x294x6mm/pcs
Chip Size:10x10x6mm
19.11 kgs/ctn 1.73 sqm/ctn
54 ctns/plt 20 pcs/ctn



DE-EMP02C
588x588x6mm/unit 294x294x6mm/pcs
Chip Size:10x10x6mm
19.11 kgs/ctn 1.73 sqm/ctn
54 ctns/plt 20 pcs/ctn



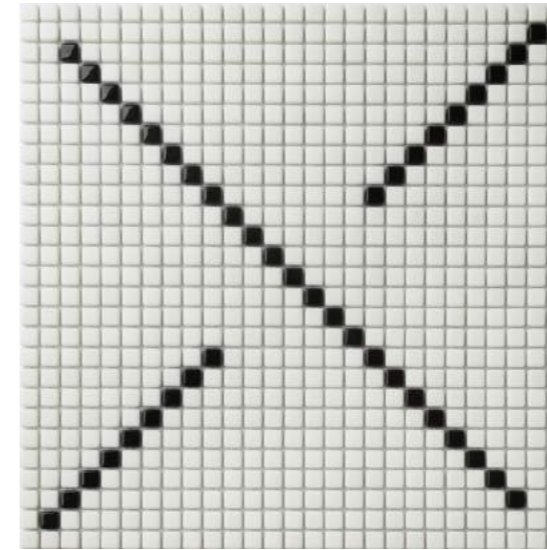
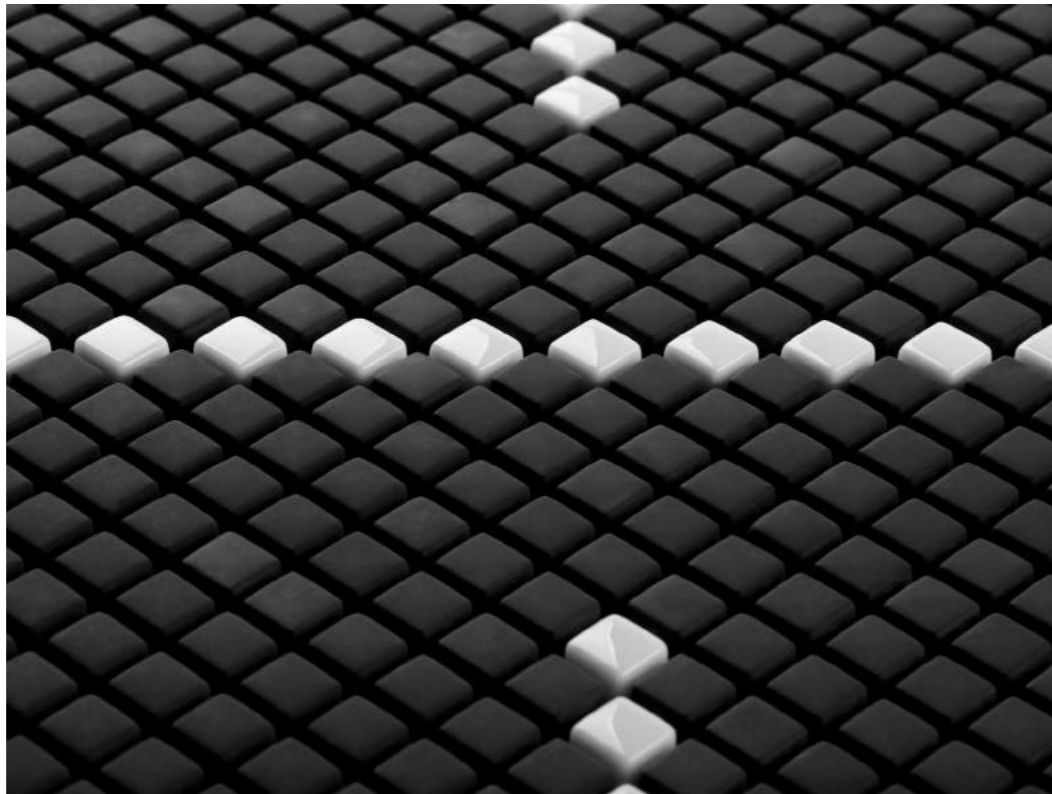
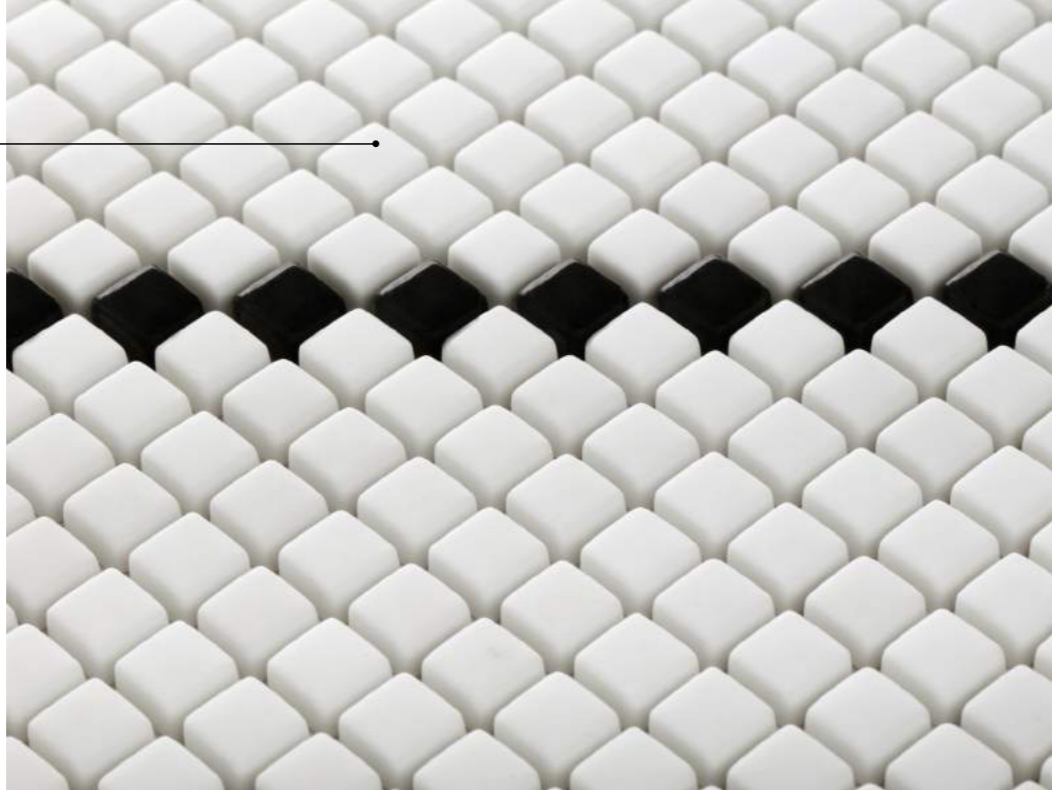
DE-EMP02D
588x588x6mm/unit 294x294x6mm/pcs
Chip Size:10x10x6mm
19.11 kgs/ctn 1.73 sqm/ctn
54 ctns/plt 20 pcs/ctn



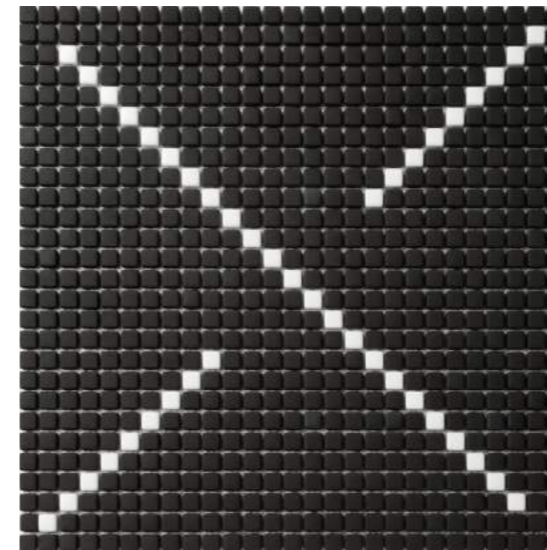
DE-EMP02E
588x588x6mm/unit 294x294x6mm/pcs
Chip Size:10x10x6mm
19.11 kgs/ctn 1.73 sqm/ctn
54 ctns/plt 20 pcs/ctn



Never Cross



DE-EMP03A
305x305x6mm/pcs
Chip Size:10x10x6mm
11.39 kgs/ctn 1.02 sqm/ctn
90 ctns/plt 11 pcs/ctn



DE-EMP03B
305x305x6mm/pcs
Chip Size:10x10x6mm
11.39 kgs/ctn 1.02 sqm/ctn
90 ctns/plt 11 pcs/ctn





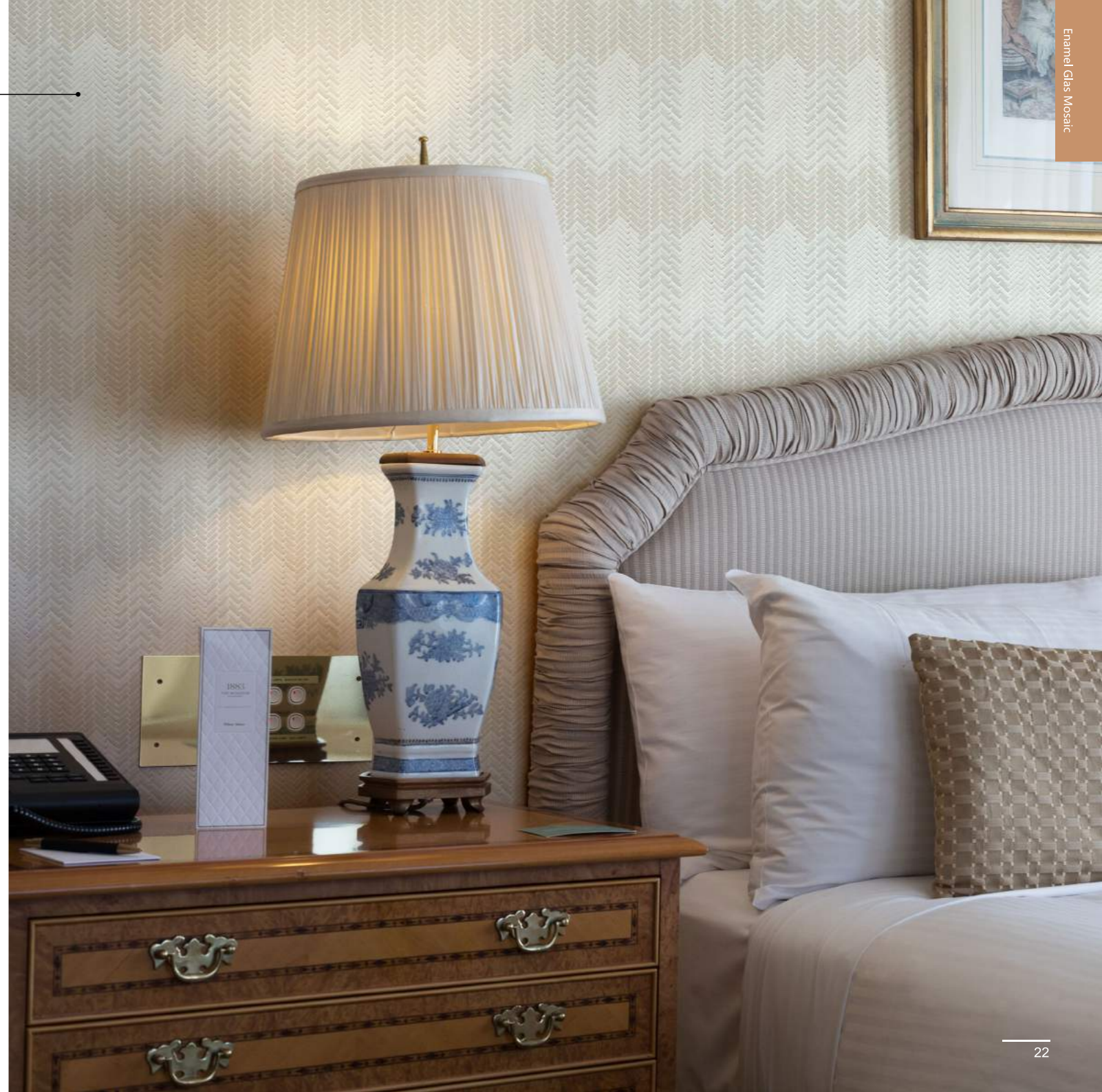
Hyacinth



DE-EMP04A
243x247x6mm/pcs
Chip Size:herringbone 20x5x6mm
6.97 kgs/ctn 0.66 sqm/ctn
90 ctns/plt 11 pcs/ctn



DE-EMP04B
243x247x6mm/pcs
Chip Size:herringbone 20x5x6mm
6.97 kgs/ctn 0.66 sqm/ctn
90 ctns/plt 11 pcs/ctn





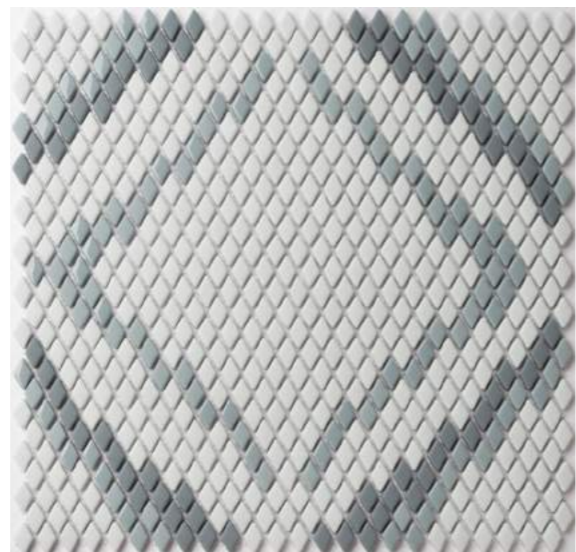
DE-EMP05A
 359x335x6mm/pcs
 Chip Size:rhombus 12x20x6mm
 14.45 kgs/ctn 1.32 sqm/ctn
 80 ctns/plt 11 pcs/ctn



DE-EMP05B
 359x335x6mm/pcs
 Chip Size:rhombus 12x20x6mm
 14.45 kgs/ctn 1.32 sqm/ctn
 80 ctns/plt 11 pcs/ctn



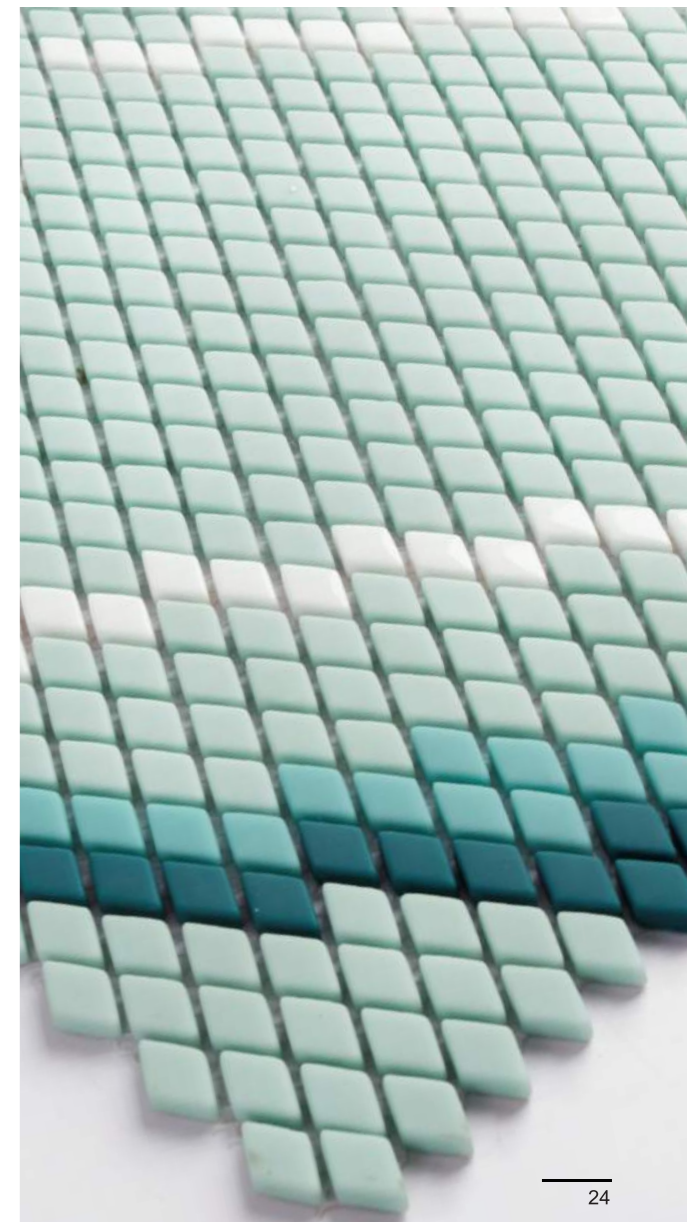
DE-EMP05C
 359x335x6mm/pcs
 Chip Size:rhombus 12x20x6mm
 14.45 kgs/ctn 1.32 sqm/ctn
 80 ctns/plt 11 pcs/ctn



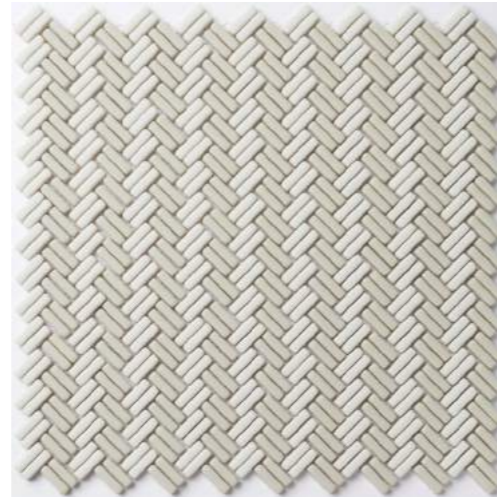
DE-EMP05D
 359x335x6mm/pcs
 Chip Size:rhombus 12x20x6mm
 14.45 kgs/ctn 1.32 sqm/ctn
 80 ctns/plt 11 pcs/ctn



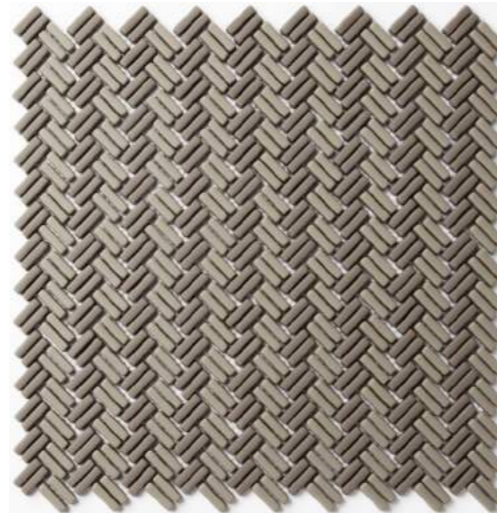
Ripple



Contexture



DE-EMP11A
263x269x6mm/pcs
Chip Size:Contexture 5x20x6mm
8.31 kgs/ctn 0.78 sqm/ctn
90 ctns/plt 11 pcs/ctn



DE-EMP11B
263x269x6mm/pcs
Chip Size:Contexture 5x20x6mm
8.31 kgs/ctn 0.78 sqm/ctn
90 ctns/plt 11 pcs/ctn



DE-EMP12A
278x278x6mm/pcs
Chip Size:Contexture 5x20x6mm
8.89 kgs/ctn 0.85 sqm/ctn
90 ctns/plt 11 pcs/ctn



DE-EMP12B
278x278x6mm/pcs
Chip Size:Contexture 5x20x6mm
8.89 kgs/ctn 0.85 sqm/ctn
90 ctns/plt 11 pcs/ctn





DE-EMP06A
 294x252x6mm/pcs
 Chip Size: rhombus 12x20x6mm
 10.04 kgs/ctn 0.81 sqm/ctn
 90 ctns/plt 11 pcs/ctn



DE-EMP06B
 294x252x6mm/pcs
 Chip Size: rhombus 12x20x6mm
 10.04 kgs/ctn 0.81 sqm/ctn
 90 ctns/plt 11 pcs/ctn

Rising Star



Pulse



DE-EMP07A
239x271x6mm/pcs
Chip Size:20X5/20x6mm
8.78 kgs/ctn 0.71 sqm/ctn
90 ctns/plt 11 pcs/ctn

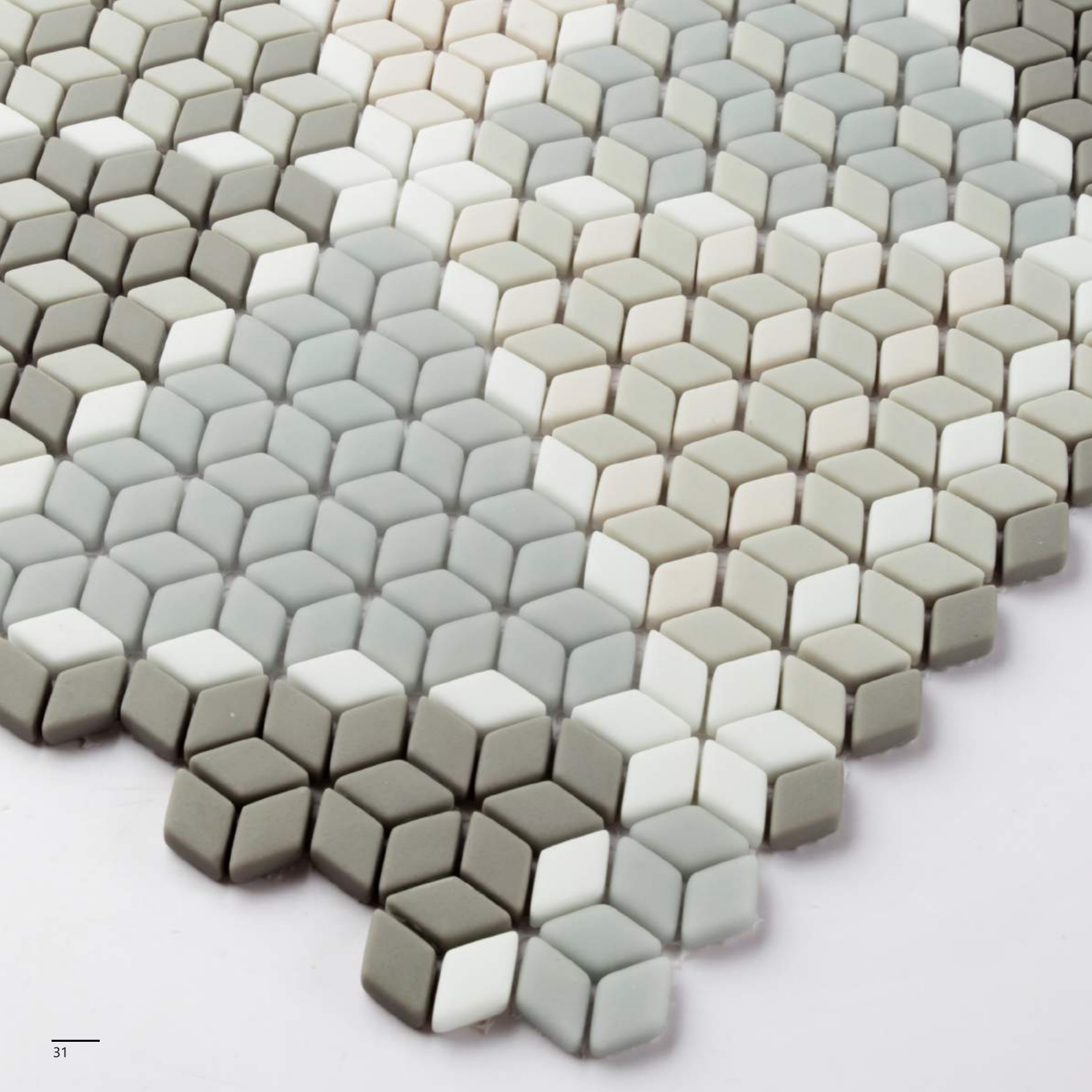


DE-EMP07B
239x271x6mm/pcs
Chip Size:20X5/20x6mm
8.78 kgs/ctn 0.71 sqm/ctn
90 ctns/plt 11 pcs/ctn

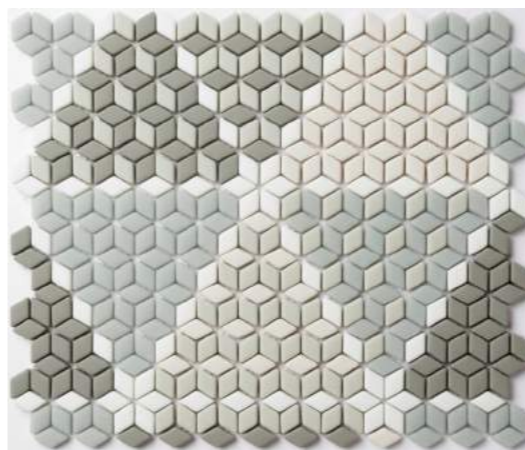


DE-EMP07C
239x271x6mm/pcs
Chip Size:20X5/20x6mm
8.78 kgs/ctn 0.71 sqm/ctn
90 ctns/plt 11 pcs/ctn

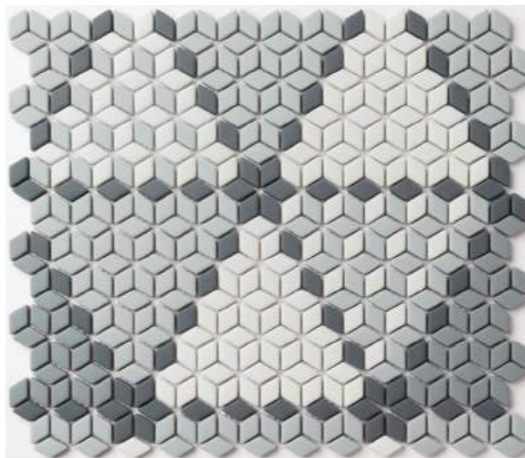




Sternhalma



DE-EMP08A
294x252x6mm/pcs
Chip Size: rhombus 12x20x6mm
10.12 kgs/ctn 0.81 sqm/ctn
90 ctns/plt 11 pcs/ctn



DE-EMP08B
294x252x6mm/pcs
Chip Size: rhombus 12x20x6mm
10.12 kgs/ctn 0.81 sqm/ctn
90 ctns/plt 11 pcs/ctn





DE-EMP10A
 296x299x6mm/pcs
 Chip Size:48X48x6+20X5x6mm
 11.68 kgs/ctn 0.97 sqm/ctn
 90 ctns/plt 11 pcs/ctn

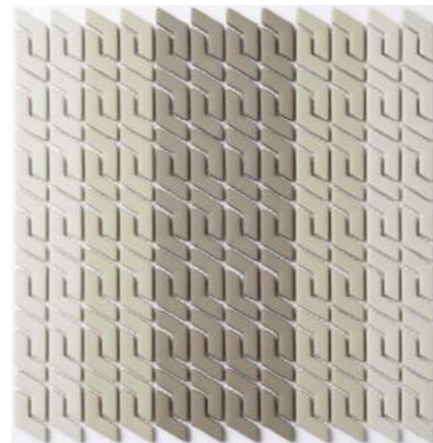


DE-EMP10B
 296x299x6mm/pcs
 Chip Size:48X48x6+20X5x6mm
 11.68 kgs/ctn 0.97 sqm/ctn
 90 ctns/plt 11 pcs/ctn





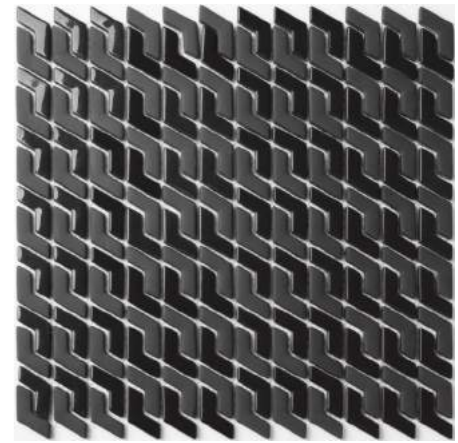
Handshake



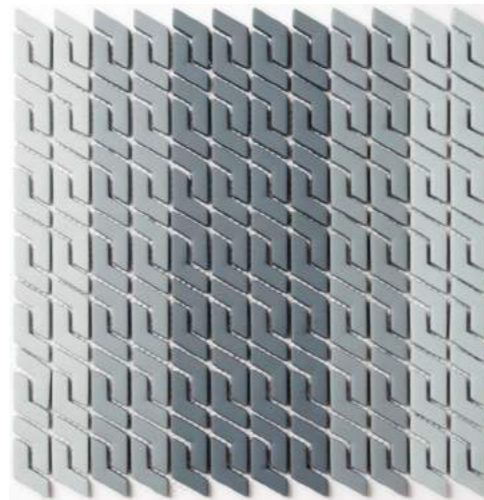
DE-EMP09B
 287x290x6mm/pcs
 Chip Size:V shapex6mm
 10.56 kgs/ctn 0.92 sqm/ctn
 90 ctns/plt 11 pcs/ctn



E05IA01mg
 287x290x6mm/pcs
 Chip Size:V shapex6mm
 10.56 kgs/ctn 0.92 sqm/ctn
 90 ctns/plt 11 pcs/ctn

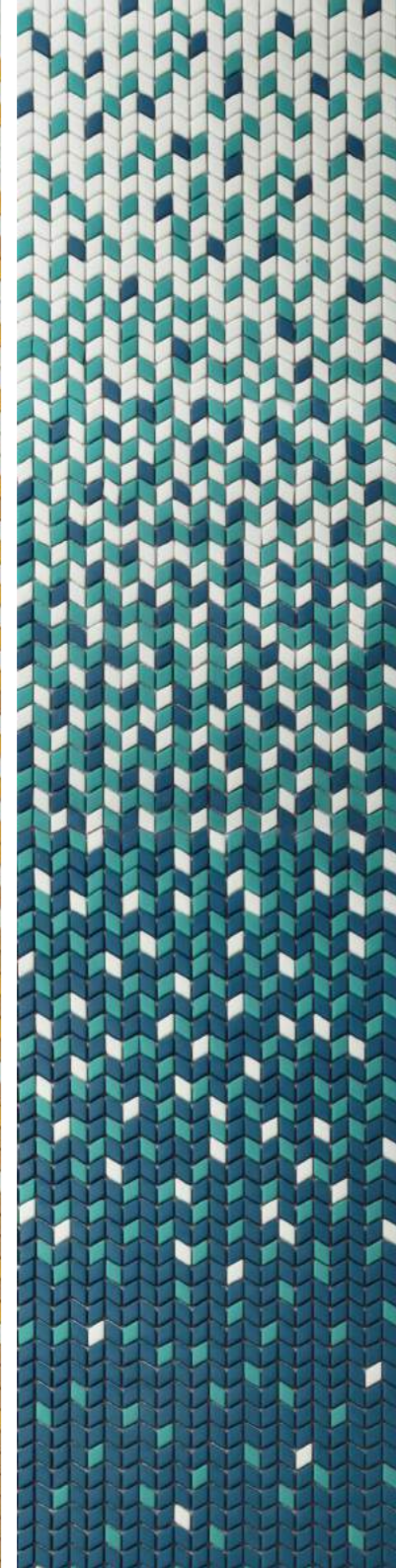


E05IA09mg
 287x290x6mm/pcs
 Chip Size:V shapex6mm
 10.56 kgs/ctn 0.92 sqm/ctn
 90 ctns/plt 11 pcs/ctn



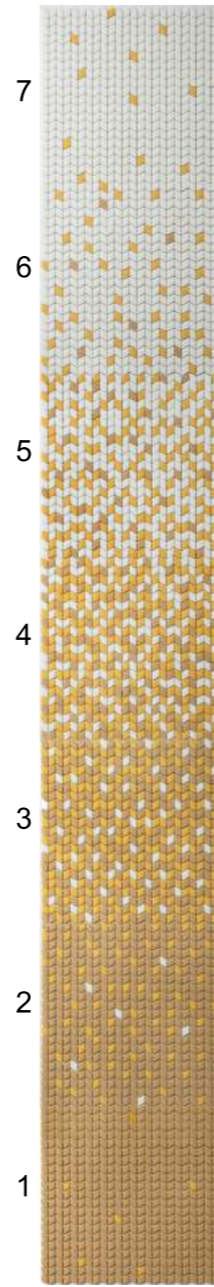
DE-EMP09A
 287x290x6mm/pcs
 Chip Size:V shapex6mm
 10.56 kgs/ctn 0.92 sqm/ctn
 90 ctns/plt 11 pcs/ctn





299x2114x6mm/unit 299x302x6mm/pcs
Chip Size: rhombus 12x20x6mm

Rhombus Shade



13.91 kgs/ctn
1.26 sqm/ctn
72 ctns/plt
14 pcs/ctn

DE-EMP13A



13.91 kgs/ctn
1.26 sqm/ctn
72 ctns/plt
14 pcs/ctn

DE-EMP13B



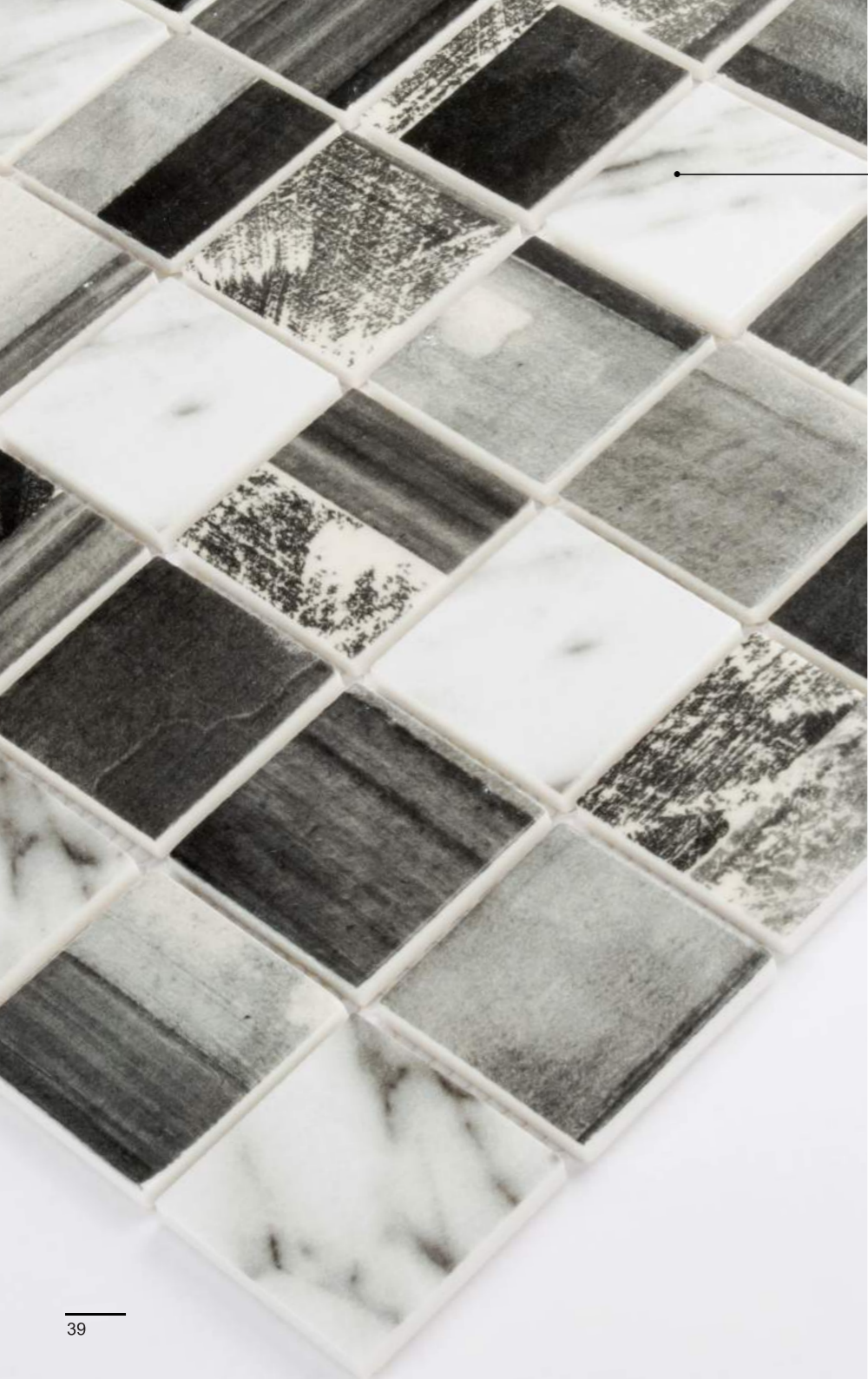
13.91 kgs/ctn
1.26 sqm/ctn
72 ctns/plt
14 pcs/ctn

DE-EMP13C



13.91 kgs/ctn
1.26 sqm/ctn
72 ctns/plt
14 pcs/ctn

DE-EMP13D



Printed Enamel -Tideway



EPD133
300x300x6mm/pcs
Chip Size:48x48x6mm
11.04 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPD233
300x300x6mm/pcs
Chip Size:48x48x6mm
11.04 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPD236
300x300x6mm/pcs
Chip Size:48x48x6mm
11.04 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPD533
300x300x6mm/pcs
Chip Size:48x48x6mm
11.04 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPJ133
300x300x6mm/pcs
Chip Size:98x23x6mm
10.83 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



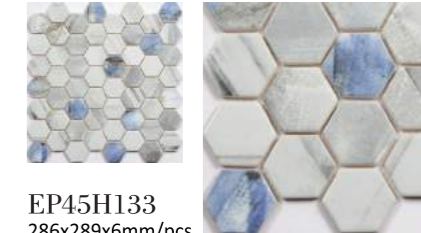
EPJ233
300x300x6mm/pcs
Chip Size:98x23x6mm
10.83 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPJ236
300x300x6mm/pcs
Chip Size:98x23x6mm
10.83 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPJ533
300x300x6mm/pcs
Chip Size:98x23x6mm
10.83 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EP45H133
286x289x6mm/pcs
Chip Size:Hexagon 45 mm
10.51 kgs/ctn 0.83 sqm/ctn
90 ctns/plt 10 pcs/ctn



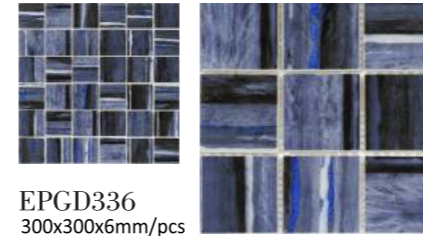
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286x289x6mm/pcs
Chip Size:Hexagon 45 mm
10.51 kgs/ctn 0.83 sqm/ctn
90 ctns/plt 10 pcs/ctn



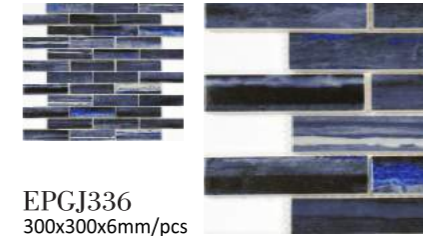
EP45H236
286x289x6mm/pcs
Chip Size:Hexagon 45 mm
10.51 kgs/ctn 0.83 sqm/ctn
90 ctns/plt 10 pcs/ctn



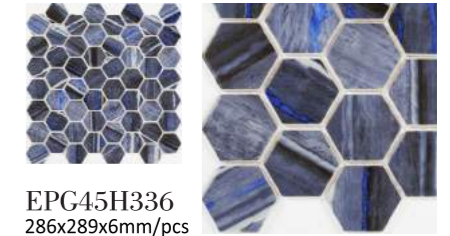
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Chip Size:Hexagon 45 mm
10.51 kgs/ctn 0.83 sqm/ctn
90 ctns/plt 10 pcs/ctn



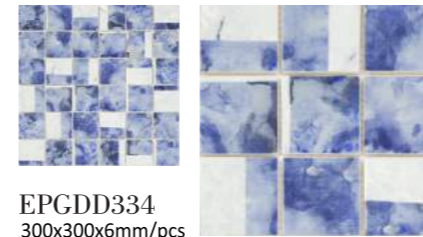
EPGD336
300x300x6mm/pcs
Chip Size:48x48x6mm
11.04 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



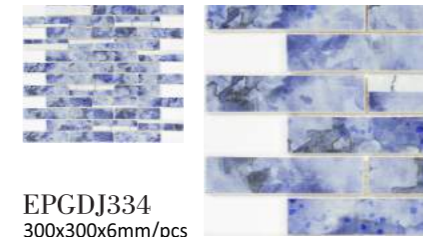
EPGJ336
300x300x6mm/pcs
Chip Size:98x23x6mm
10.83 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



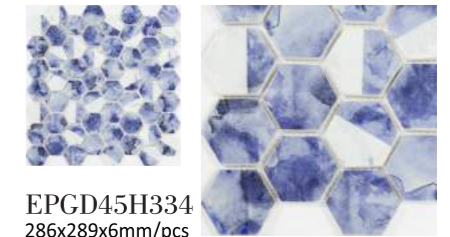
EPG45H336
286x289x6mm/pcs
Chip Size:Hexagon 45 mm
10.51 kgs/ctn 0.83 sqm/ctn
90 ctns/plt 10 pcs/ctn



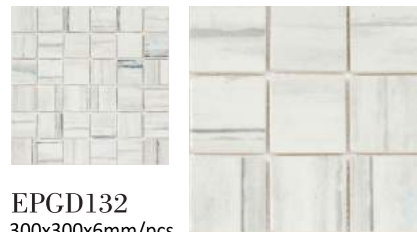
EPGDD334
300x300x6mm/pcs
Chip Size:48x48x6mm
11.04 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPGDJ334
300x300x6mm/pcs
Chip Size:98x23x6mm
10.83 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPGD45H334
286x289x6mm/pcs
Chip Size:Hexagon 45 mm
10.51 kgs/ctn 0.83 sqm/ctn
90 ctns/plt 10 pcs/ctn



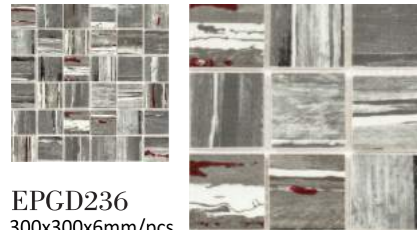
EPGD132
300x300x6mm/pcs
Chip Size:48x48x6mm
11.04 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



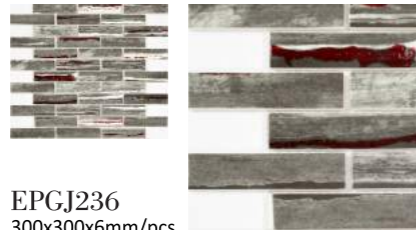
EPGJ132
300x300x6mm/pcs
Chip Size:98x23x6mm
10.83 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



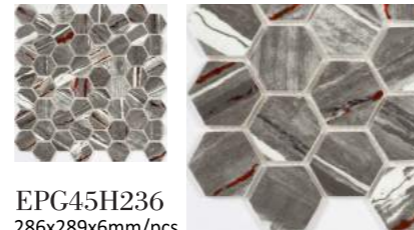
EPG45H132
286x289x6mm/pcs
Chip Size:Hexagon 45 mm
10.51 kgs/ctn 0.83 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPGD236
300x300x6mm/pcs
Chip Size:48x48x6mm
11.04 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn



EPGJ236
300x300x6mm/pcs
Chip Size:98x23x6mm
10.83 kgs/ctn 0.9 sqm/ctn
90 ctns/plt 10 pcs/ctn

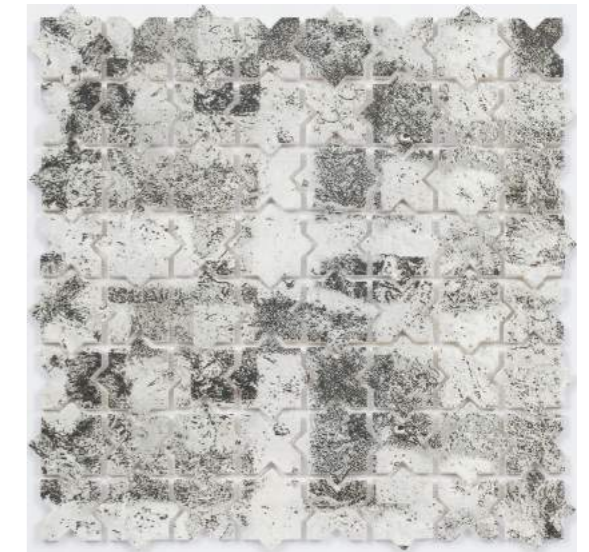


EPG45H236
286x289x6mm/pcs
Chip Size:Hexagon 45 mm
10.51 kgs/ctn 0.83 sqm/ctn
90 ctns/plt 10 pcs/ctn

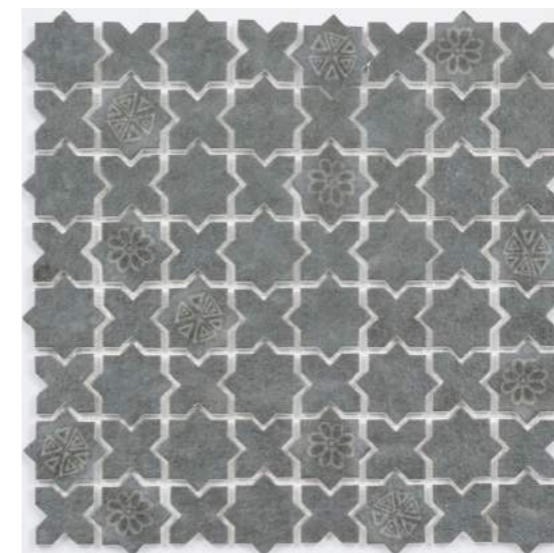




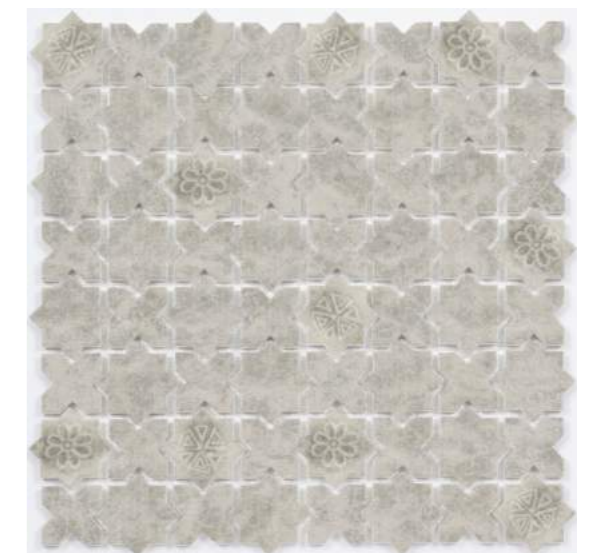
EPQX13
 288x288x6mm/pcs
 Chip Size:45x45x6mm
 9.02 kgs/ctn 0.83 sqm/ctn
 90 ctns/plt 10 pcs/ctn



EPQX16
 288x288x6mm/pcs
 Chip Size:45x45x6mm
 9.02 kgs/ctn 0.83 sqm/ctn
 90 ctns/plt 10 pcs/ctn



EPQX26
 288x288x6mm/pcs
 Chip Size:45x45x6mm
 9.02 kgs/ctn 0.83 sqm/ctn
 90 ctns/plt 10 pcs/ctn



EPQX53
 288x288x6mm/pcs
 Chip Size:45x45x6mm
 9.02 kgs/ctn 0.83 sqm/ctn
 90 ctns/plt 10 pcs/ctn

Printed Enamel-Flower



MEPD161-F
 300x300x6mm/pcs
 Chip Size:48x48x6mm
 16.11 kgs/ctn 1.26 sqm/ctn
 72 ctns/plt 14 pcs/ctn



MEPD343-F
 300x300x6mm/pcs
 Chip Size:48x48x6mm
 16.11 kgs/ctn 1.26 sqm/ctn
 72 ctns/plt 14 pcs/ctn



MEP45H161-F
 324x280x6mm/pcs
 Chip Size:45x52x6 mm
 16.11 kgs/ctn 1.27 sqm/ctn
 72 ctns/plt 14 pcs/ctn



MEP45H343-F
 324x280x6mm/pcs
 Chip Size:45x52x6mm
 16.11 kgs/ctn 1.27 sqm/ctn
 72 ctns/plt 14 pcs/ctn



MEPCL&S242-F
 300x300x6mm/pcs
 Chip Size:31x48/98/148x6mm
 16.11 kgs/ctn 1.26 sqm/ctn
 72 ctns/plt 14 pcs/ctn



MEPCL&S552-F
 300x300x6mm/pcs
 Chip Size:31x48/98/148x6mm
 16.11 kgs/ctn 1.26 sqm/ctn
 72 ctns/plt 14 pcs/ctn

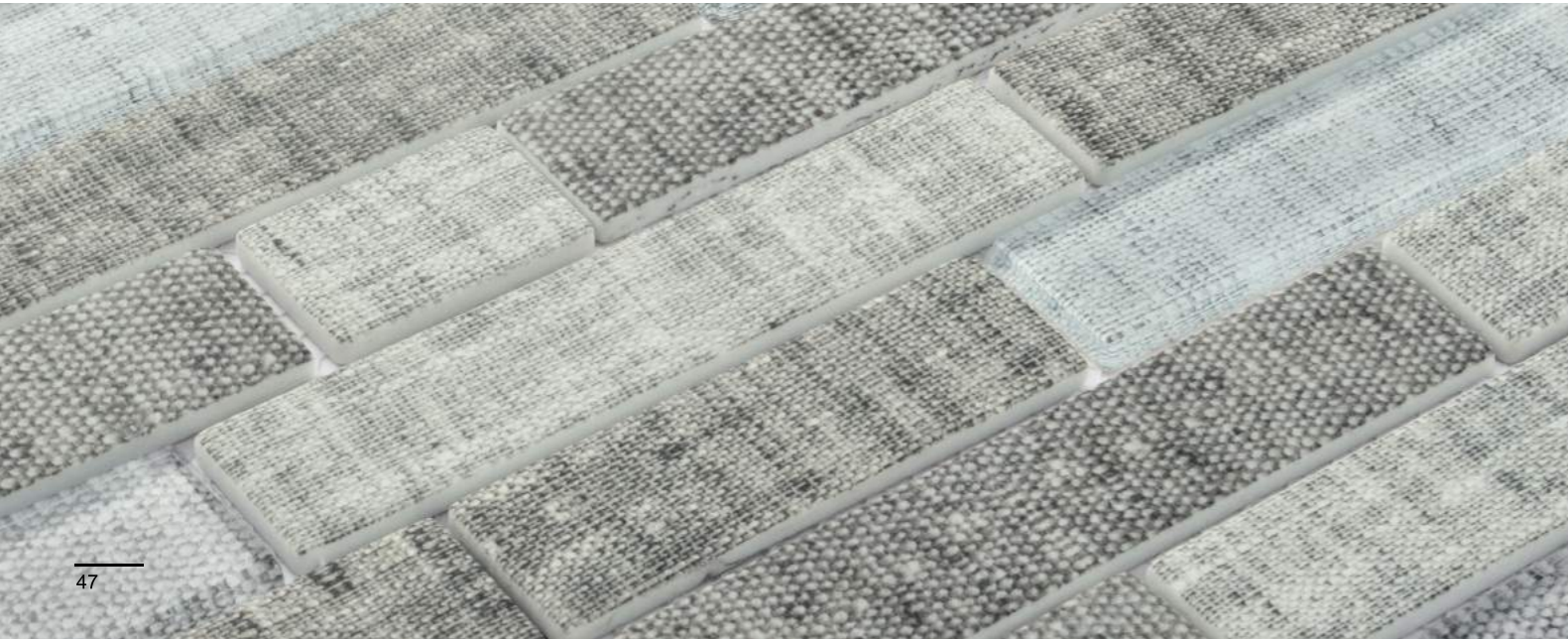
Printed Enamel-Grid



MEPCL&S234-G
300x300x6mm/pcs
Chip Size:31x48/98/148x6mm
16.11 kgs/ctn 1.26 sqm/ctn
72 ctns/plt 14 pcs/ctn

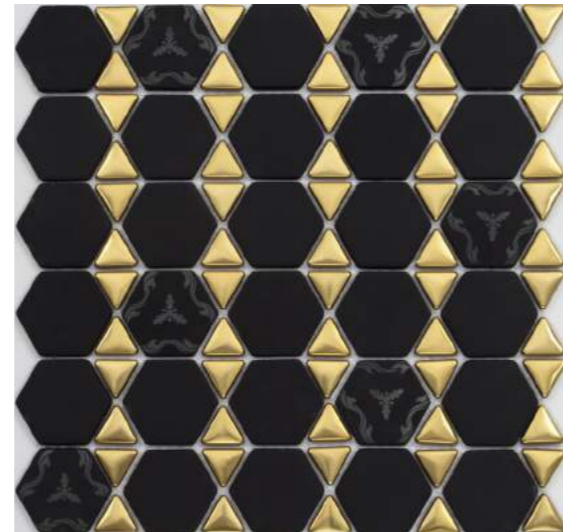


MEPCL&S535-G
300x300x6mm/pcs
Chip Size:31x48/98/148x6mm
16.11 kgs/ctn 1.26 sqm/ctn
72 ctns/plt 14 pcs/ctn

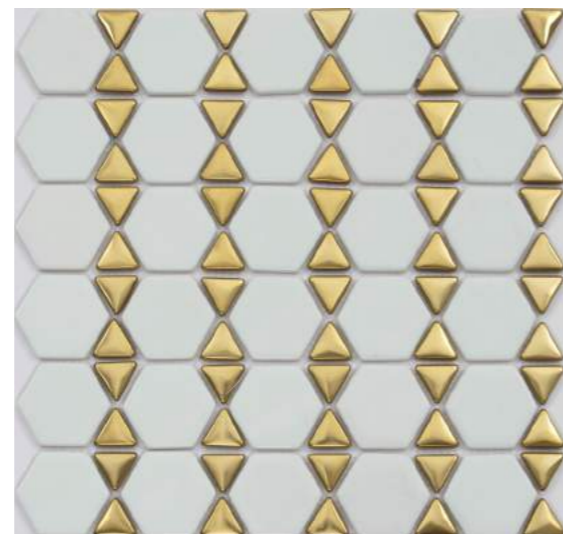


Eanmel & Materials Mix





MES3DH27m-ENG
 303x302x6mm/pcs
 Chip Size:Hexagon48x6+triangle25x6mm
 12.88 kgs/ctn 1.01 sqm/ctn
 81 ctns/plt 11 pcs/ctn

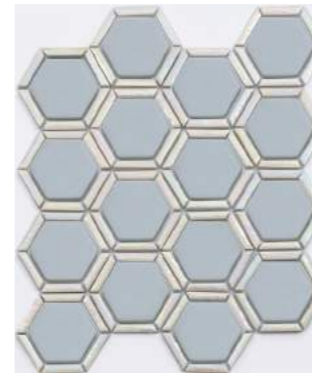


MES3DH15-ENG
 303x302x6mm/pcs
 Chip Size:Hexagon48x6+triangle25x6mm
 12.88 kgs/ctn 1.01 sqm/ctn
 81 ctns/plt 11 pcs/ctn



METHDH12m
 263x227x6mm/pcs
 Chip Size:Hexagon48x6+
 ladder34x28x6x6 mm

8.48 kgs/ctn 0.66 sqm/ctn
 90 ctns/plt 11 pcs/ctn



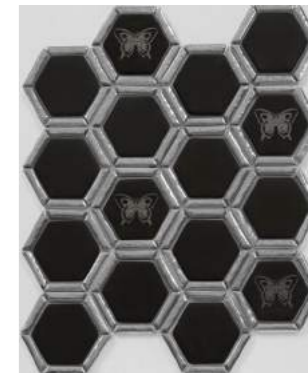
METHDH22m
 263x227x6mm/pcs
 Chip Size:Hexagon48x6+
 ladder34x28x6x6 mm

8.48 kgs/ctn 0.66 sqm/ctn
 90 ctns/plt 11 pcs/ctn



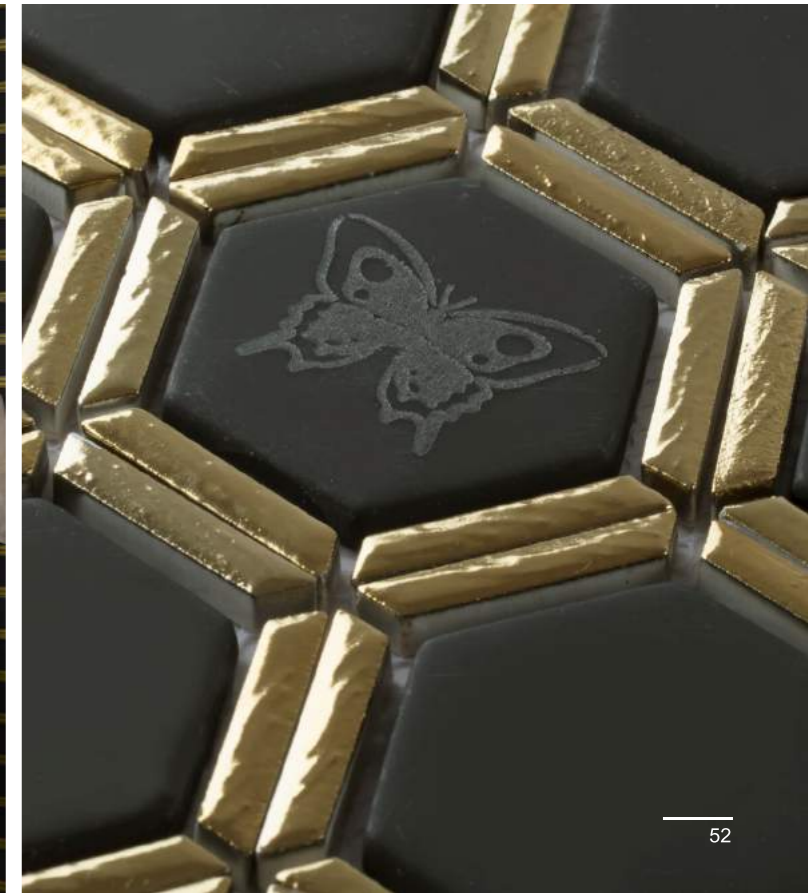
METHDH27m-ENG
 263x227x6mm/pcs
 Chip Size:Hexagon48x6+
 ladder34x28x6x6 mm

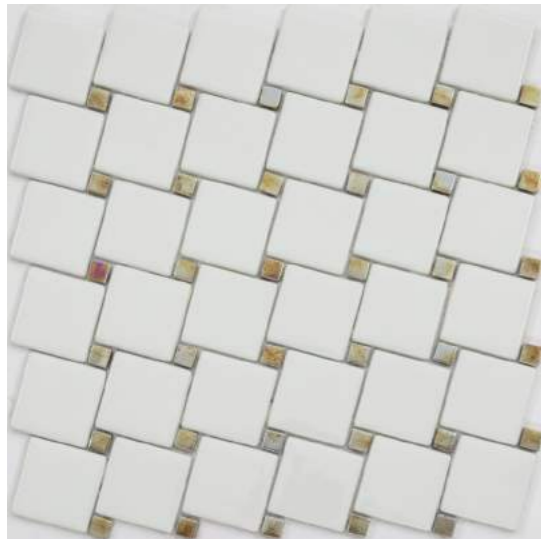
8.48 kgs/ctn 0.66 sqm/ctn
 90 ctns/plt 11 pcs/ctn



METHDH28m-ENG
 263x227x6mm/pcs
 Chip Size:Hexagon48x6+
 ladder34x28x6x6 mm

8.48 kgs/ctn 0.66 sqm/ctn
 90 ctns/plt 11 pcs/ctn





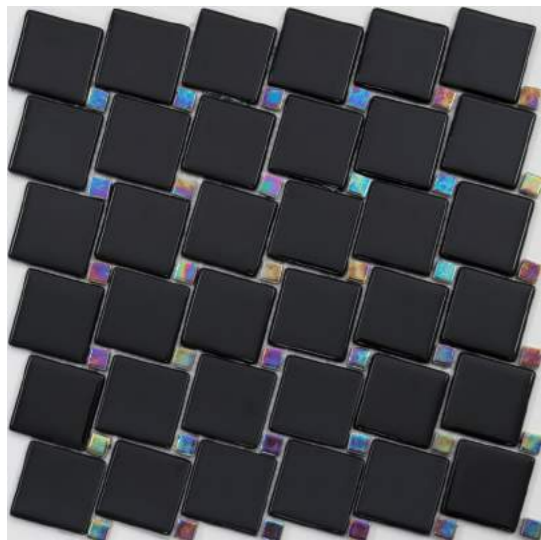
ME12TD13

307x307x6mm/pcs
 Chip Size:48x48x6+12x12x6 mm
 14.53 kgs/ctn 1.04 sqm/ctn
 72 ctns/plt 11 pcs/ctn



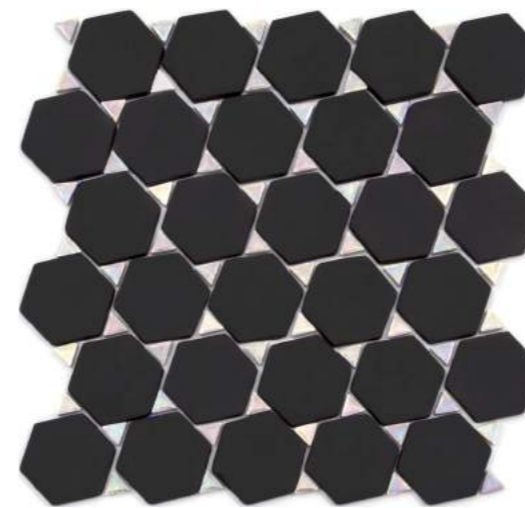
MET3DH13

268x279x6mm/pcs
 Chip Size:48Hexagon+triangle14x6mm
 11.23 kgs/ctn 0.82 sqm/ctn
 90 ctns/plt 11 pcs/ctn



ME12TD29

307x307x6mm/pcs
 Chip Size:48x48x6+12x12x6 mm
 14.53 kgs/ctn 1.04 sqm/ctn
 72 ctns/plt 11 pcs/ctn



MET3DH28m

268x279x6mm/pcs
 Chip Size:48Hexagon+triangle14x6mm
 11.23 kgs/ctn 0.82 sqm/ctn
 90 ctns/plt 11 pcs/ctn





MEA2022IA01
258x298x6mm/pcs
Chip Size:3d ladder 24x47x20x6+Hexagon 41.5x4 mm
9.03 kgs/ctn 0.85 sqm/ctn
90 ctns/plt 11 pcs/ctn



Sketch



Sketch 09m
300x300x6mm/pcs
Chip Size:48x48x6mm
14.53 kgs/ctn 0.99 sqm/ctn
72 ctns/plt 11 pcs/ctn





3D Enamel-Long Bend Hexagon



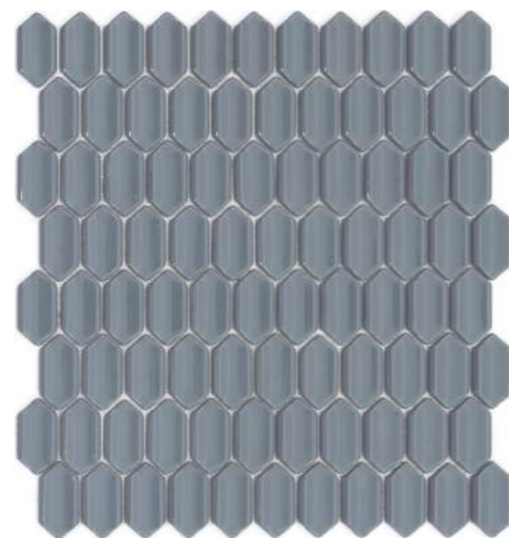
ME25I233
290x309x6mm/pcs
Chip Size:Bend long hexagon25x48x6 mm
10.67 kgs/ctn 0.99 sqm/ctn
90 ctns/plt 11 pcs/ctn



ME25I421
290x309x6mm/pcs
Chip Size:Bend long hexagon25x48x6 mm
10.67 kgs/ctn 0.99 sqm/ctn
90 ctns/plt 11 pcs/ctn



E25I01
290x309x6mm/pcs
Chip Size:Bend long hexagon25x48x6 mm
10.67 kgs/ctn 0.99 sqm/ctn
90 ctns/plt 11 pcs/ctn



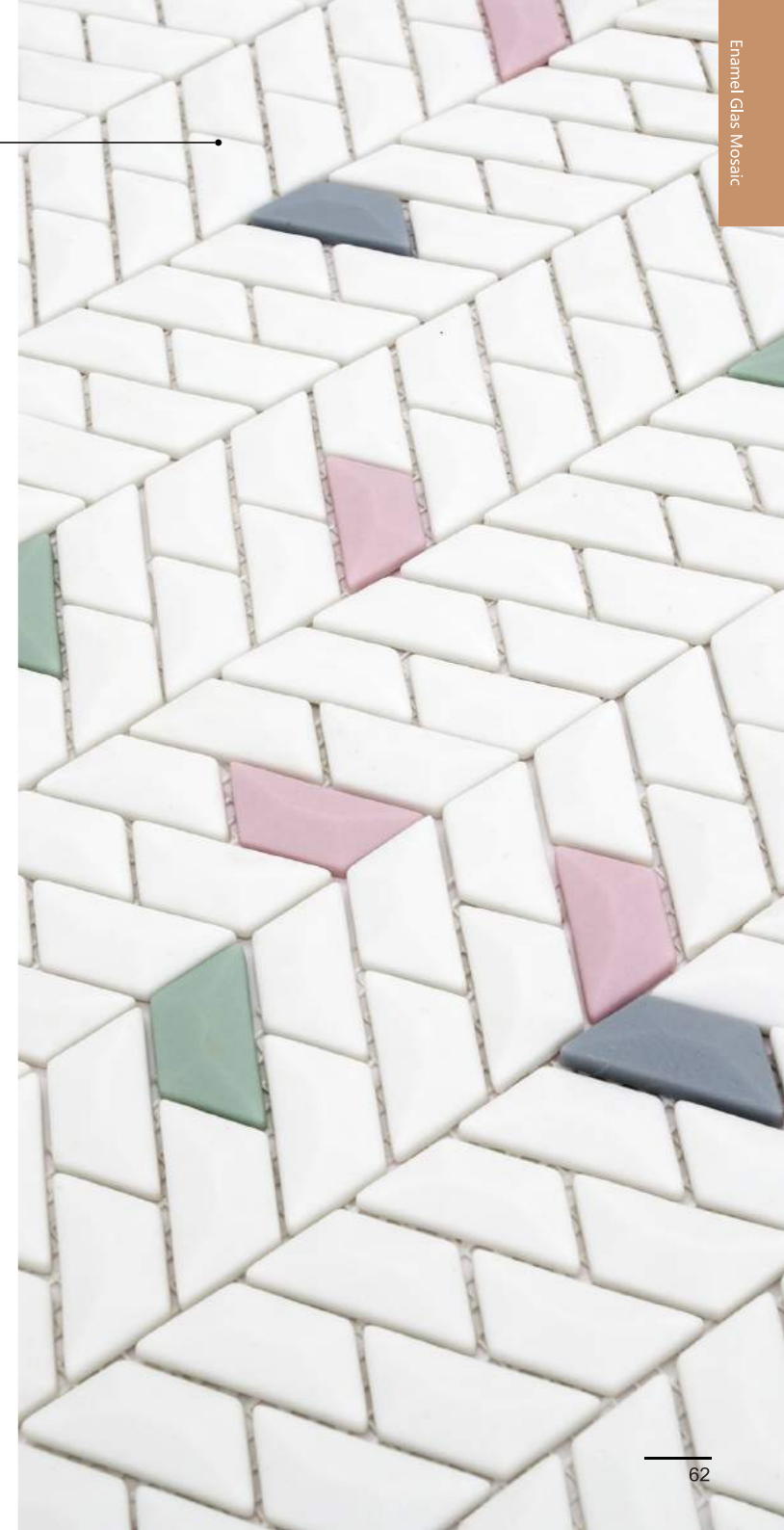
E25I215
290x309x6mm/pcs
Chip Size:Bend long hexagon25x48x6 mm
10.67 kgs/ctn 0.99 sqm/ctn
90 ctns/plt 11 pcs/ctn



3D Enamel-Arrow



ME20IC131m
244x256x6mm/pcs
Chip Size:3d ladder arrow 24x47x20x6 mm
7.66 kgs/ctn 0.69 sqm/ctn
90 ctns/plt 11 pcs/ctn





MELA20IB229i
 244x256x6mm/pcs
 Chip Size:3d ladder arrow 24x47x20x4/6 mm
 7.66 kgs/ctn 0.69 sqm/ctn
 90 ctns/plt 11 pcs/ctn



MELA20IB229mg
 244x256x6mm/pcs
 Chip Size:3d ladder arrow 24x47x20x4/6 mm
 7.66 kgs/ctn 0.69 sqm/ctn
 90 ctns/plt 11 pcs/ctn



MELA20IC223mg
 244x256x6mm/pcs
 Chip Size:3d ladder arrow 24x47x20x4/6 mm
 7.66 kgs/ctn 0.69 sqm/ctn
 90 ctns/plt 11 pcs/ctn

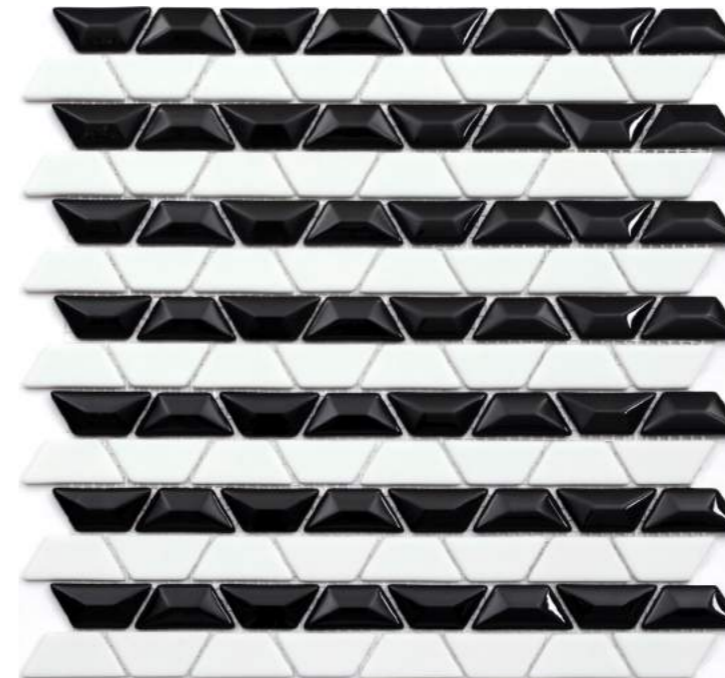


MELA20IC229mg
 244x256x6mm/pcs
 Chip Size:3d ladder arrow 24x47x20x4/6 mm
 7.66 kgs/ctn 0.69 sqm/ctn
 90 ctns/plt 11 pcs/ctn





3D Enamel-Ladder



MELA20ID229mg
296x307x6mm/pcs
Chip Size:3d ladder arrow 24x47x20x4/6 mm
7.66 kgs/ctn 1 sqm/ctn
90 ctns/plt 11 pcs/ctn

3D Enamel-Football Shape



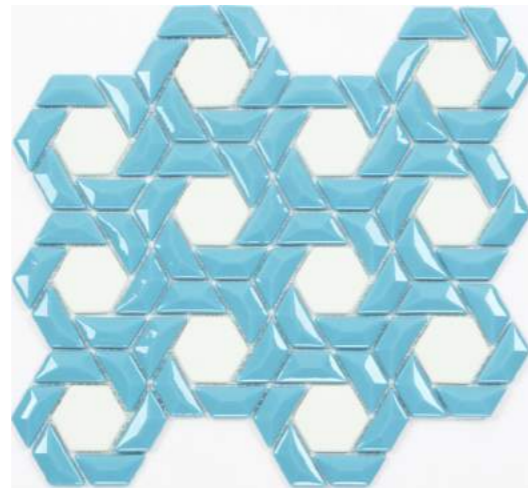
E2022IA01mg
 258x298x6mm/pcs
 Chip Size:3d ladder 24x47x20x6+Hexagon 41.5x4 mm
 8.45 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



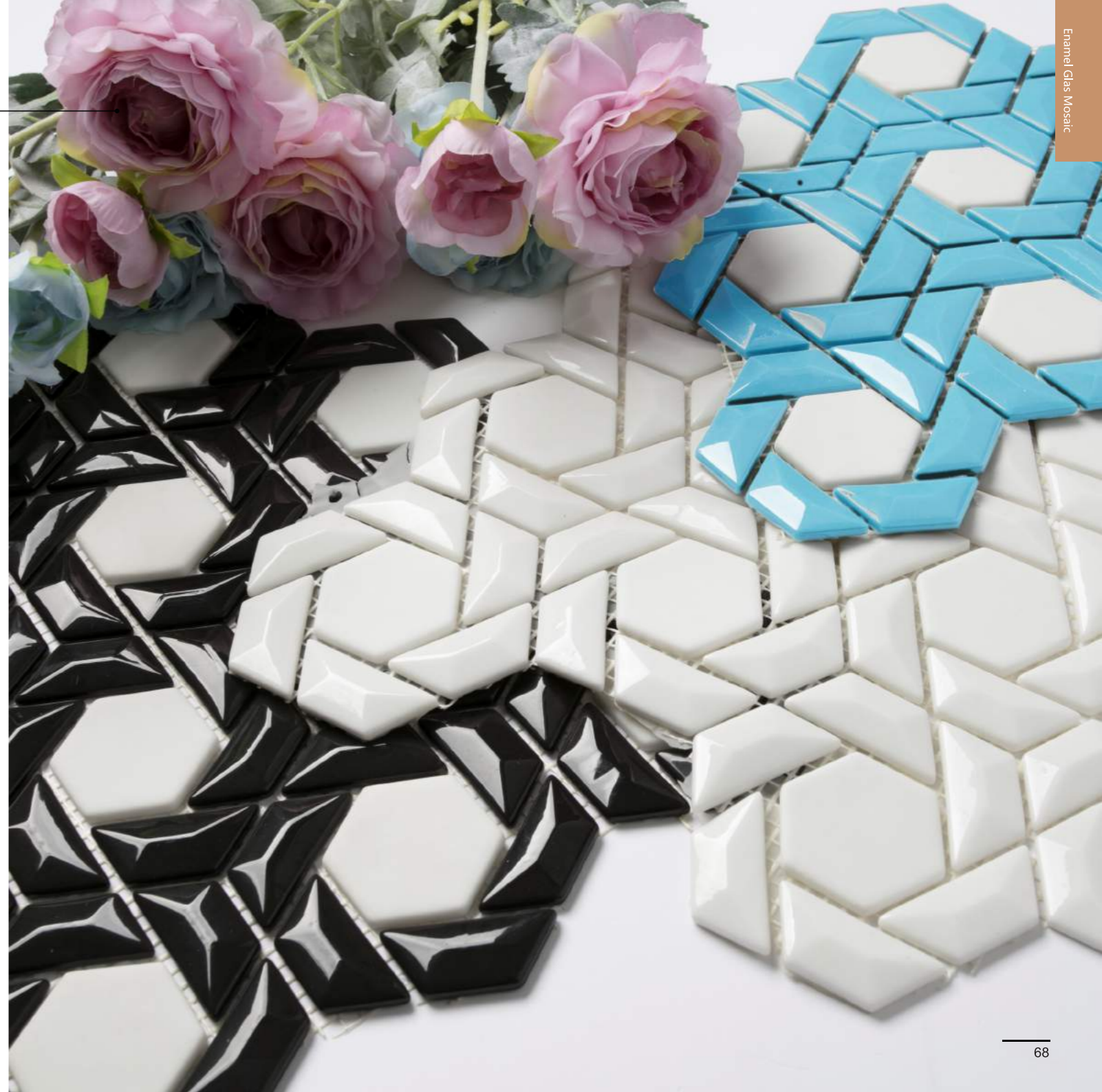
E2022IA09mg
 258x298x6mm/pcs
 Chip Size:3d ladder 24x47x20x6+Hexagon 41.5x4 mm
 8.45 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



ME2022IA229mg
 258x298x6mm/pcs
 Chip Size:3d ladder 24x47x20x6+Hexagon 41.5x4 mm
 8.45 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



ME2022IA323
 258x298x6mm/pcs
 Chip Size:3d ladder 24x47x20x6+Hexagon 41.5x4 mm
 8.45 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



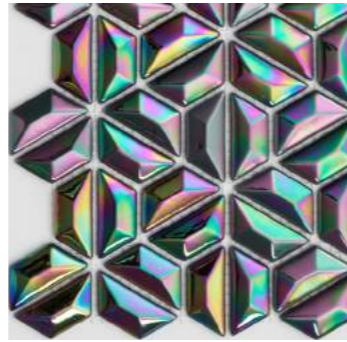


3D Enamel-Hexagon





E20I01i
 259x300x6mm/pcs
 Chip Size:3d ladder 24x47x20x6mm
 8.86 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



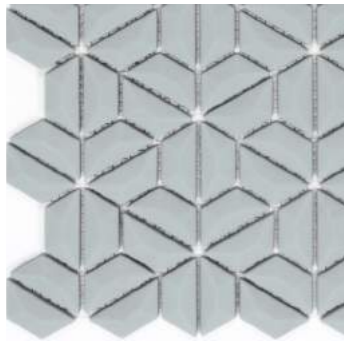
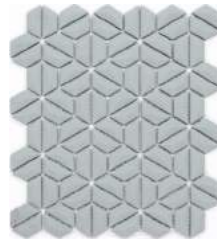
E20I09i
 259x300x6mm/pcs
 Chip Size:3d ladder 24x47x20x6mm
 8.86 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



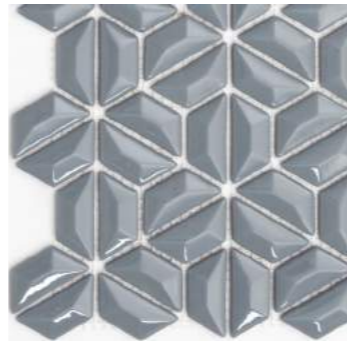
E21I01m
 257x297x6mm/pcs
 Chip Size:Hexagon tunnel 41.5x6 mm
 11.59 kgs/ctn 0.84 sqm/ctn
 90 ctns/plt 11 pcs/ctn



E21I09
 257x297x6mm/pcs
 Chip Size:Hexagon tunnel 41.5x6 mm
 11.59 kgs/ctn 0.84 sqm/ctn
 90 ctns/plt 11 pcs/ctn



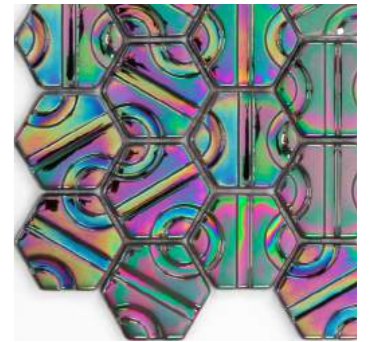
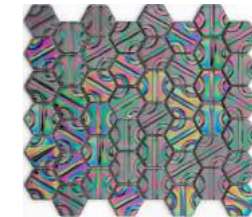
E20I213m
 259x300x6mm/pcs
 Chip Size:3d ladder 24x47x20x6mm
 8.86 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



E20I215
 259x300x6mm/pcs
 Chip Size:3d ladder 24x47x20x6mm
 8.86 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



E21I01i
 257x297x6mm/pcs
 Chip Size:Hexagon tunnel 41.5x6 mm
 11.59 kgs/ctn 0.84 sqm/ctn
 90 ctns/plt 11 pcs/ctn



E21I09i
 257x297x6mm/pcs
 Chip Size:Hexagon tunnel 41.5x6 mm
 11.59 kgs/ctn 0.84 sqm/ctn
 90 ctns/plt 11 pcs/ctn



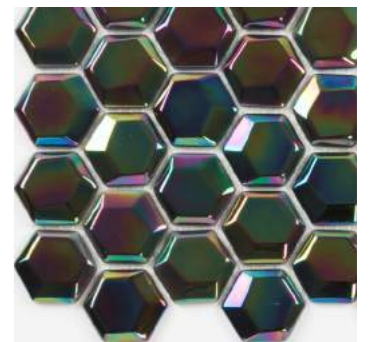
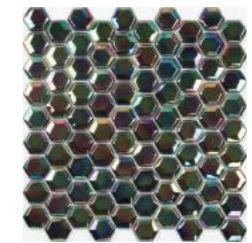
ME20IEB233
 259x300x6mm/pcs
 Chip Size:3d ladder 24x47x20x6mm
 8.86 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



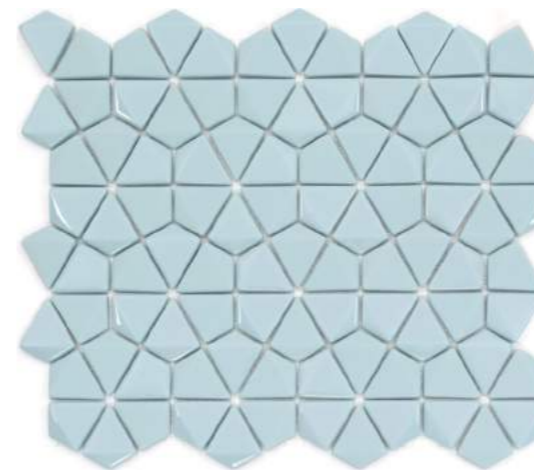
ME20IEC233
 259x300x6mm/pcs
 Chip Size:3d ladder 24x47x20x6mm
 8.86 kgs/ctn 0.85 sqm/ctn
 90 ctns/plt 11 pcs/ctn



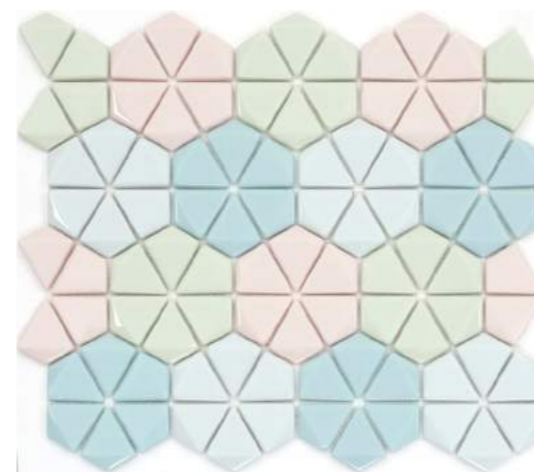
E24I01m
 285x296x6mm/pcs
 Chip Size:3d Hexagon 32x6mm
 10.36 kgs/ctn 0.93 sqm/ctn
 90 ctns/plt 11 pcs/ctn



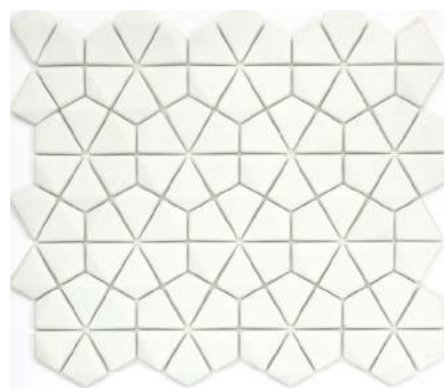
E24I09i
 285x296x6mm/pcs
 Chip Size:3d Hexagon 32x6mm
 10.36 kgs/ctn 0.93 sqm/ctn
 90 ctns/plt 11 pcs/ctn



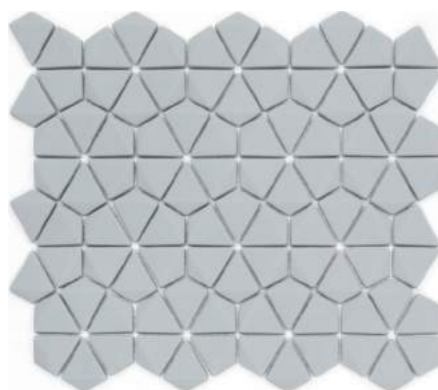
E23I311mg
 254x294x6mm/pcs
 Chip Size:1/6Hexagon 40x35x6mm
 10.70 kgs/ctn 0.82 sqm/ctn
 90 ctns/plt 11 pcs/ctn



ME23I343
 254x294x6mm/pcs
 Chip Size:1/6Hexagon 40x35x6mm
 10.70 kgs/ctn 0.82 sqm/ctn
 90 ctns/plt 11 pcs/ctn



E23I01m
 254x294x6mm/pcs
 Chip Size:1/6Hexagon 40x35x6mm
 10.70 kgs/ctn 0.82 sqm/ctn
 90 ctns/plt 11 pcs/ctn



E23I213m
 254x294x6mm/pcs
 Chip Size:1/6Hexagon 40x35x6mm
 10.70 kgs/ctn 0.82 sqm/ctn
 90 ctns/plt 11 pcs/ctn



E23I09
 254x294x6mm/pcs
 Chip Size:1/6Hexagon 40x35x6mm
 10.70 kgs/ctn 0.82 sqm/ctn
 90 ctns/plt 11 pcs/ctn



INSTRUCTION FOR MOSAIC INSTALLATION



1. Preparing substrates



6. Cut off the excess and fit the mosaic edge



2. Prepare tools



7. Fill the edges



3. Preparing adhesives



8. Apply the grout to the tile sheet surface



4. Apply the adhesives to the substrates



9. Use a soft towel to remove excess adhesive on the surface



5. Apply the tile sheet



10. Curing for 24 hours before use

1. Prepare the substrate
The substrate should be smooth, clean, dust-free and waterproof. If you take the waterproof measures, remember to do it at least one day in advance. Generally the waterproof coating will completely dry after 24 hours. If there is dust on the wall, you can apply a layer of varnish first, and dry it after 24 hours. If there is a socket, remove the panel of the socket and install it after the paving is completed.

2. Prepare for the tools and materials

Materials:
Choose the suitable adhesive and joint mixture.

Tools:



Electric Drill



Notched Spatula



Rubber Float



Rigid Cellulose Sponge



Spacer



Spirit Level



Trowel



Grout Sealer



Diamond Glass Cutting Tools



Wet Saw

3. Installation steps:

After confirming that the wall is flat and ashless, you can start paving. First, mark the position first. If the wall has an inner corner and an outer corner, the horizontal line needs to ensure that the outer corner mosaic is complete and cut the inner corner only. If it is for kitchen backsplash, it needs to ensure that the mosaic at the vertical line which touches the countertop is complete.

Please make sure that the quantity of the mosaic is enough. And please be careful to disconnect the power of the outlet before installation.

Mixed adhesive. Adhesive generally sell in barrels. You can use this bucket directly. You should add water according to the proportion on the package. Remember do not add too much water at a time, a little bit is ok. Mortar will be very sticky, you can be mixed with a electric drill or a trowel. Also note that if the place is large, such as a swimming pool, don't mix too much at a time, because the mortar has about four hours of work time, and the outdoor will be shorter.

In addition, prepare a bucket of water, when you rest, you can put the trowel in the water, or it will be difficult to wash.

You need to scrape the adhesive on the wall from bottom to top.

The first sheet is installed at the side of the outer wall and at the bottom, then up and on the other side. And it is better to use a tile spacer between each sheet to keep the seams from being misaligned.

Each patch should be flattened. It can be hammered with a wooden board or compacted with a rubber sheet.

After 24 hours of paving, the joint can be filled. Scraping the adhesive back and forth with an 45 degree angle to ensure that each joint is filled. Note that the tile spacer should be removed before filling the joint.

Wipe off the excrescent adhesive with a clean and large sponge. Note that you should wash the sponge before you wipe it each time.

Usually we will prepare a few buckets, to wash most of the grout in the first bucket, then wash in the second bucket, at last it will be very clean in the third bucket.

After the excrescent adhesive is cleaned, the grout is almost dry, but there is still a layer of residue on the surface. It should use a clean soft dry cloth to wipe off the surface residue.

DISCLAIMER

Our mosaic images are product images.

These can differ from the original sheet, depending on personal impressions, bathes, optic, natural stone material variations, monitor color variation and printing methods.

Also the color Random mixed color mosaics images may also differ from the original mosaic sheet, because the paving arrangement is also a random match, can not be exactly the same as the product image we displayed

We highly recommend to have a look at the original mosaic and to order enough sheets for the installation. We cannot always guarantee the delivery of the same batch in your reorders.

All information is provided without warranty, errors and omissions expected.

QUALITY MANAGEMENT

Our quality is about more than a certification or the QC process. Quality relies on the attitude to the products consistency and customer's trust. It combines the production speed, flexibility, teamwork and attention to the details. More important, it is about how we view our obligation and how we respond to the needs.

TEST REPORT

INSPECTION AND QUARANTINE COMPREHENSIVE TECHNOLOGY CENTRE OF FOSHAN ENTRY-EXIT INSPECTION & QUARANTINE BUREAU

TEST REPORT

Report No: 25201809067 Page 4 of 8

Class	Properties	Test Method	Requirements	Results	Verdict
Physical property	Water absorption	ISO 10545-3	≤18.0%	8.0%	P
	Product size fluctuation	ISO 10545-1	Individual maximum 0.5%	0.20%	P
	Breaking strength, N/m²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (dry)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P

Enamel Glass Mosaic

INSPECTION AND QUARANTINE COMPREHENSIVE TECHNOLOGY CENTRE OF FOSHAN ENTRY-EXIT INSPECTION & QUARANTINE BUREAU

TEST REPORT

Report No: 25201809066 Page 4 of 8

Class	Properties	Test Method	Requirements	Results	Verdict
Physical property	Water absorption	ISO 10545-3	≤18.0%	8.0%	P
	Product size fluctuation	ISO 10545-1	Individual maximum 0.5%	0.20%	P
	Breaking strength, N/m²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (dry)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P

Glass Mosaic

INSPECTION AND QUARANTINE COMPREHENSIVE TECHNOLOGY CENTRE OF FOSHAN ENTRY-EXIT INSPECTION & QUARANTINE BUREAU

TEST REPORT

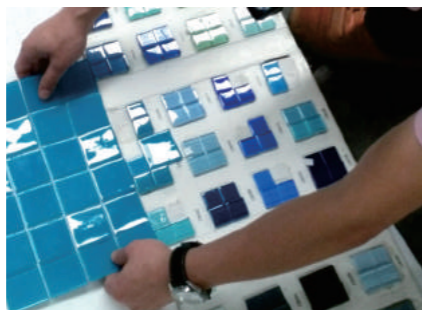
Report No: 25201809070 Page 4 of 8

Class	Properties	Test Method	Requirements	Results	Verdict
Physical property	Water absorption	ISO 10545-3	≤18.0%	8.0%	P
	Product size fluctuation	ISO 10545-1	Individual maximum 0.5%	0.20%	P
	Breaking strength, N/m²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (dry)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P

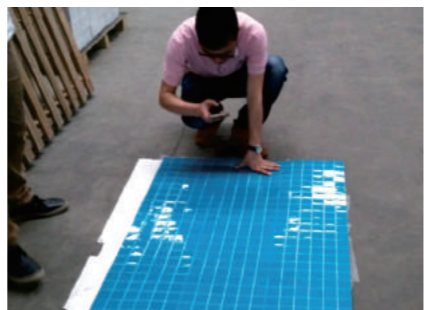
Crystal Mosaic



Check The size



Check the color



Checking the overall effect



Check The packing



Check The container



Check The Loading and take photo for stock

INSPECTION AND QUARANTINE COMPREHENSIVE TECHNOLOGY CENTRE OF FOSHAN ENTRY-EXIT INSPECTION & QUARANTINE BUREAU

TEST REPORT

Report No: 25201809072 Page 4 of 8

Class	Properties	Test Method	Requirements	Results	Verdict
Physical property	Water absorption	ISO 10545-3	≤18.0%	8.0%	P
	Product size fluctuation	ISO 10545-1	Individual maximum 0.5%	0.20%	P
	Breaking strength, N/m²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (dry)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P

Ceramic Mosaic

INSPECTION AND QUARANTINE COMPREHENSIVE TECHNOLOGY CENTRE OF FOSHAN ENTRY-EXIT INSPECTION & QUARANTINE BUREAU

TEST REPORT

Report No: 25201809071 Page 4 of 8

Class	Properties	Test Method	Requirements	Results	Verdict
Physical property	Water absorption	ISO 10545-3	≤18.0%	8.0%	P
	Product size fluctuation	ISO 10545-1	Individual maximum 0.5%	0.20%	P
	Breaking strength, N/m²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (dry)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P

Stainless Steel Mosaic

INSPECTION AND QUARANTINE COMPREHENSIVE TECHNOLOGY CENTRE OF FOSHAN ENTRY-EXIT INSPECTION & QUARANTINE BUREAU

TEST REPORT

Report No: 25201809073 Page 4 of 8

Class	Properties	Test Method	Requirements	Results	Verdict
Physical property	Water absorption	ISO 10545-3	≤18.0%	8.0%	P
	Product size fluctuation	ISO 10545-1	Individual maximum 0.5%	0.20%	P
	Breaking strength, N/m²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm²	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (dry)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P
	Modulus of rupture, N/mm² (soak)	ISO 10545-4	≥35	360	P

Stone Mosaic

4-5	6ST73BD275	95	6095LHTG208m	131	C	DE-EMP06A	27	E20I213m	71
48TINK111	6ST73BD365	96	6095LHTG209	131	Coffee L&N10	DE-EMP06B	27	E20I215	71
48TINK214	6ST73BD375	96	6095LHTG212	131	Coffee L&N23	DE-EMP07A	29	E21I01i	72
48TINK516	6ST73BD476	96	6095LHTG501	131	Coffee L&N28	DE-EMP07B	29	E21I01m	72
48195LHTG101	6STG73BD161	97	6095LHTGB101	131	Coffee L&N56	DE-EMP07C	29	E21I09	72
48195LHTG305	6STG73BD263	97	6095LHTGB102	131	D	DE-EMP08A	32	E21I09i	72
48195LHTG403	6STG73BD269	97	6095LHTGB207	132	DE-EMP01A	DE-EMP08B	32	E23I01m	73
48195LHTG502	6STGAR161	89	6095LHTGB209	132	DE-EMP01B	DE-EMP09A	36	E23I09	73
48195LHTINK101	6STGAR263	89	6095LHTGB305	132	DE-EMP01C	DE-EMP09B	35	E23I213m	73
48195LHTINK214	6STGAR269	89	6095LHTGB401	132	DE-EMP01D	DE-EMP10A	33	E23I311mg	74
48195LHTINK215	6STGAR375	89	6095LHTGB404	132	DE-EMP01E	DE-EMP10B	33	E24I01m	72
51HTINK101	6STGAR467	89	6095LHTGB414	132	DE-EMP02A	DE-EMP11A	25	E24I09i	72
6	6STGAR476	89	6095LHTGB501	132	DE-EMP02B	DE-EMP11B	25	E25I01	59
6CINKD22	6STGFSB161	80	6095LHTGB503	132	DE-EMP02C	DE-EMP12A	26	E25I215	59
6CINKD32	6STGFSB263	80	6095LHTGB504	132	DE-EMP02D	DE-EMP12B	26	E2022IA01mg	67
6CINKD92	6STGFSB273	80	6095LHTGB505	132	DE-EMP02E	DE-EMP13A	38	E2022IA09mg	67
6CINKJ22	6STGRE161	91	7		DE-EMP03A	DE-EMP13B	38	EP45H133	40
6CINKJ32	6STGRE263	91	73TINK323	126	DE-EMP03B	DE-EMP13C	38	EP45H233	40
6CINKJ92	6STGRE269	91	73TINK324	126	DE-EMP04A	DE-EMP13D	38	EP45H236	40
6ST73BD161	6STSFSB161	80	73TINK325	126	DE-EMP04B			EP45H533	40
6ST73BD263	6095LHTG101	131	73TINK326	125	DE-EMP05A	E	E05IA01mg	EPD133	40
6ST73BD265	6095LHTG111	131			DE-EMP05B	E05IA09mg	36	EPD233	40
6ST73BD269	6095LHTG112	131			DE-EMP05C	E20I01i	71	EPD236	40
6ST73BD273	6095LHTG202	131			DE-EMP05D	E20I09i	71	EPD533	40

<u>EPG45H132</u>	<u>41</u>	<u>InkCT Twilight</u>	<u>108</u>	<u>M6STGFSA426</u>	<u>84</u>	<u>M8CFMTD11</u>	<u>115</u>	<u>ME20IC131m</u>	<u>62</u>	<u>MET3DH13</u>	<u>54</u>
<u>EPG45H236</u>	<u>41</u>	M		<u>M6STGFSA231</u>	<u>81</u>	<u>M8CFMTD51</u>	<u>116</u>	<u>ME20IEB233</u>	<u>71</u>	<u>MET3DH28m</u>	<u>54</u>
<u>EPG45H336</u>	<u>42</u>	<u>M4INKCFSB21</u>	<u>109</u>	<u>M6STGFSA232</u>	<u>81</u>	<u>M8CFMTJ11</u>	<u>115</u>	<u>ME20IEC233</u>	<u>71</u>	<u>METHDH12m</u>	<u>52</u>
<u>EPGD45H334</u>	<u>42</u>	<u>M4INKCFSB22</u>	<u>109</u>	<u>M6STGFSA233</u>	<u>81</u>	<u>M8CFMTJ51</u>	<u>116</u>	<u>ME23I343</u>	<u>74</u>	<u>METHDH22m</u>	<u>52</u>
<u>EPGD132</u>	<u>41</u>	<u>M4INKCFSB23</u>	<u>110</u>	<u>M6STGFSA234</u>	<u>81</u>	<u>M8ECTCY10</u>	<u>122</u>	<u>ME25I233</u>	<u>60</u>	<u>METHDH27m-ENG</u>	<u>52</u>
<u>EPGD236</u>	<u>41</u>	<u>M4INKCFSB24</u>	<u>110</u>	<u>M6STGFSA325</u>	<u>82</u>	<u>M8ECTCY23</u>	<u>122</u>	<u>ME25I421</u>	<u>60</u>	S	
<u>EPGD336</u>	<u>42</u>	<u>M6ST23FSB221</u>	<u>85</u>	<u>M6STGFSA426</u>	<u>82</u>	<u>M8ECTCY28</u>	<u>122</u>	<u>ME2022IA229mg</u>	<u>67</u>	<u>Sketch 09m</u>	<u>57</u>
<u>EPGDD334</u>	<u>42</u>	<u>M6ST23FSB224</u>	<u>85</u>	<u>M6STGRE231</u>	<u>93</u>	<u>M8ECTCY58</u>	<u>122</u>	<u>ME2022IA323</u>	<u>67</u>	<u>SKETCH01 8FO209</u>	<u>105</u>
<u>EPGDJ334</u>	<u>42</u>	<u>M6ST23FSB231</u>	<u>86</u>	<u>M6STGRE234</u>	<u>93</u>	<u>M8ECTCY72</u>	<u>122</u>	<u>MEA2022IA01</u>	<u>55</u>	<u>SKETCH01 8FO556</u>	<u>105</u>
<u>EPGJ132</u>	<u>41</u>	<u>M6ST23FSB232</u>	<u>86</u>	<u>M6STGRE325</u>	<u>94</u>	<u>M8PSASRE25</u>	<u>112</u>	<u>MELA20IB229i</u>	<u>63</u>	<u>SKETCH02 8FO257</u>	<u>103</u>
<u>EPGJ236</u>	<u>41</u>	<u>M6ST23FSB233</u>	<u>86</u>	<u>M6STGRE426</u>	<u>94</u>	<u>M8PSASRE28</u>	<u>112</u>	<u>MELA20IB229mg</u>	<u>63</u>	<u>SKETCH02 8FO552</u>	<u>106</u>
<u>EPGJ336</u>	<u>42</u>	<u>M6ST23FSB234</u>	<u>86</u>	<u>M8CCTL&S131</u>	<u>118</u>	<u>M8PSASRE55</u>	<u>112</u>	<u>MELA20IC223mg</u>	<u>63</u>	<u>SKETCH03 8FO252</u>	<u>106</u>
<u>EPJ133</u>	<u>40</u>	<u>M6STAR122</u>	<u>88</u>	<u>M8CCTL&S235</u>	<u>118</u>	<u>M8PSASRE95</u>	<u>112</u>	<u>MELA20IC229mg</u>	<u>63</u>	<u>SKETCH04 8FO103</u>	<u>106</u>
<u>EPJ233</u>	<u>40</u>	<u>M6STAR221</u>	<u>88</u>	<u>M8CCTL&S239</u>	<u>118</u>	<u>M8PVC21B</u>	<u>111</u>	<u>MELA20ID229mg</u>	<u>66</u>		
<u>EPJ236</u>	<u>40</u>	<u>M6STAR222</u>	<u>88</u>	<u>M8CCTRBYB25</u>	<u>119</u>	<u>M8PVC35B</u>	<u>111</u>	<u>MEP45H161-F</u>	<u>45</u>		
<u>EPJ533</u>	<u>40</u>	<u>M6STAR226</u>	<u>88</u>	<u>M8CCTRBYB55</u>	<u>119</u>	<u>M8PVC55B</u>	<u>111</u>	<u>MEP45H343-F</u>	<u>45</u>		
<u>EPQX13</u>	<u>44</u>	<u>M6STG73BD221</u>	<u>100</u>	<u>M8CDTC11</u>	<u>120</u>	<u>M8PVC63B</u>	<u>111</u>	<u>MEPCL&S234-G</u>	<u>47</u>		
<u>EPQX16</u>	<u>44</u>	<u>M6STG73BD223</u>	<u>100</u>	<u>M8CDTC22</u>	<u>120</u>	<u>M51HTINK111</u>	<u>128</u>	<u>MEPCL&S535-G</u>	<u>47</u>		
<u>EPQX26</u>	<u>44</u>	<u>M6STG73BD244</u>	<u>100</u>	<u>M8CDTC28</u>	<u>120</u>	<u>M51HTINK214</u>	<u>128</u>	<u>MEPCL&S242-F</u>	<u>47</u>		
<u>EPQX53</u>	<u>44</u>	<u>M6STGFSA231</u>	<u>84</u>	<u>M8CDTC52</u>	<u>120</u>	<u>M51HTINK217</u>	<u>128</u>	<u>MEPCL&S552-F</u>	<u>47</u>		
I		<u>M6STGFSA232</u>	<u>84</u>	<u>M8CFMAD20</u>	<u>115</u>	<u>M51HTINK510</u>	<u>128</u>	<u>MEPD161-F</u>	<u>46</u>		
<u>InkCT Esprit</u>	<u>108</u>	<u>M6STGFSA233</u>	<u>84</u>	<u>M8CFMAD28</u>	<u>115</u>	<u>M51HTINK516</u>	<u>128</u>	<u>MEPD343-F</u>	<u>46</u>		
<u>InkCT Fresh</u>	<u>108</u>	<u>M6STGFSA234</u>	<u>84</u>	<u>M8CFMAJ28</u>	<u>115</u>	<u>ME12TD13</u>	<u>53</u>	<u>MES3DH15-ENG</u>	<u>51</u>		
<u>InkCT Renew</u>	<u>108</u>	<u>M6STGFSA325</u>	<u>84</u>	<u>M8CFMJ20</u>	<u>115</u>	<u>ME12TD29</u>	<u>53</u>	<u>MES3DH27m-ENG</u>	<u>51</u>		

